

Hardware Maintenance Manual

Lenovo
ThinkStation



Lenovo

ThinkStation P3 Ultra SFF G2

First Edition (September 2025)

© Copyright Lenovo 2025.

LIMITED AND RESTRICTED RIGHTS NOTICE: If data or software is delivered pursuant to a General Services Administration "GSA" contract, use, reproduction, or disclosure is subject to restrictions set forth in Contract No. GS-35F-05925.

Contents

About this manual iii

Chapter 1. Important safety information. 1

General safety	1
Electrical safety	2
Safety inspection guide	3
Handling electrostatic discharge-sensitive devices	4
Grounding requirements	4
Safety notices (multi-lingual translations)	4

Chapter 2. Important service information. 27

Strategy for replacing FRUs	27
Strategy for replacing a hard disk drive or a solid-state drive	27
Important notice for replacing a system board	27
How to use error codes	28
Strategy for replacing FRUs for CTO, special-bid, and standard models.	28
Product definition	28
FRU identification	28

Chapter 3. Product overview 29

Front	29
Rear	29

Chapter 4. Service checkout and symptom-to-FRU index 31

Service checkout	31
Problem determination tips	31
Symptom-to-FRU index	32
Hard disk drive boot error	32
Power supply problems	33
Beep symptoms	33
POST error codes	34
Miscellaneous error conditions	35
Undetermined problems	37
Recover from a BIOS update failure	37
Clear CMOS	38

Chapter 5. RAID 39

What is RAID	39
RAID Level.	39

Configure the system BIOS to enable SATA RAID functionality	39
Configure RAID in UEFI mode	39

Chapter 6. Diagnostics 41

Basic procedure for resolving computer problems	41
UEFI diagnostic program	41
Lenovo diagnostic tools	42
Self-help resources	42

Chapter 7. Hardware removal and installation 45

Handling static-sensitive devices	45
Service tool kit	45
Major FRUs and CRUs	47
System board illustration	49
Prerequisites for hardware replacement	51
Expand your computer	52
Removing and installing hardware	53
External options	53
Power adapter and power cord	53
Dust filter	54
Chassis	55
M.2 solid-state drive thermal kit.	56
M.2 solid-state drive	58
Hard disk drive fan	62
3.5-inch hard disk drive bracket kit	63
3.5-inch hard disk drive	64
LED cable and holder.	65
Memory module	66
PCI-Express bracket	68
PCI-Express card (including graphics card)	69
PCI-Express card converter	70
BMC card	72
Board to board Thunderbolt 4 card	73
Internal speaker	74
Wi-Fi card and Wi-Fi card shield	75
Wi-Fi antenna and Wi-Fi antenna cable	76
Heatsink	77
Microprocessor	78
System board.	80
CMOS battery	82

Appendix A. Notices and trademarks. 85

About this manual

This manual provides service and reference information for ThinkStation® computers listed on the front cover.

Illustrations in this manual might look different from your product.

Use this manual along with the advanced diagnostic tests to troubleshoot problems.

Important: It is recommended that these products be repaired by trained service technicians. For customers electing to repair their own ThinkStation products, please follow all instructions carefully. Use this manual along with the advanced diagnostic tests to troubleshoot problems effectively. Before servicing a ThinkStation computer, be sure to read and understand Chapter 1 “Important safety information” on page 1.

Chapter 1. Important safety information

General safety

Follow these rules to ensure general safety:

- Observe good housekeeping in the area of the machines during and after maintenance.
- When lifting any heavy object:
 1. Ensure you can stand safely without slipping.
 2. Distribute the weight of the object equally between your feet.
 3. Use a slow lifting force. Never move suddenly or twist when you attempt to lift.
 4. Lift by standing or by pushing up with your leg muscles; this action removes the strain from the muscles in your back.

Attention: Do not attempt to lift any objects that weigh more than 16 kg (35 lb) or objects that you think are too heavy for you.

- Do not perform any action that causes hazards to the customer, or that makes the equipment unsafe.
- Before you start the machine, ensure that other people are not in a hazardous position.
- Place removed covers and other parts in a safe place, away from all personnel, while you are servicing the machine.
- Keep your tool case away from walk areas so that other people will not trip over it.
- Do not wear loose clothing that can be trapped in the moving parts of a machine. Ensure that your sleeves are fastened or rolled up above your elbows. If your hair is long, fasten it.
- Insert the ends of your necktie or scarf inside clothing or fasten it with a nonconductive clip, approximately 8 centimeters (3 inches) from the end.
- Do not wear jewelry, chains, metal-frame eyeglasses, or metal fasteners for your clothing.

Remember: Metal objects are good electrical conductors.

- Wear safety glasses when you are: hammering, drilling, soldering, cutting wire, attaching springs, using solvents, or working in any other conditions that might be hazardous to your eyes.
- After service, reinstall all safety shields, guards, labels, and ground wires. Replace any safety device that is worn or defective.
- Reinstall all covers correctly before returning the machine to the customer.

CAUTION:



Keep fingers and other parts of your body away from hazardous, moving parts. If you suffer an injury, seek medical care immediately.

CAUTION:



Avoid contact with hot components inside the computer. During operation, some components become hot enough to burn the skin. Before you open the computer cover, turn off the computer, disconnect power, and wait approximately 10 minutes for the components to cool.

Electrical safety



CAUTION:

Electrical current from power, telephone, and communication cables can be hazardous. To avoid personal injury or equipment damage, disconnect the attached power cords, telecommunication systems, networks, and modems before you open the computer covers, unless instructed otherwise in the installation and configuration procedures.

Observe the following rules when working on electrical equipment.

Important: Use only approved tools and test equipment. Some hand tools have handles covered with a soft material that does not insulate you when working with live electrical currents. Many customers have, near their equipment, rubber floor mats that contain small conductive fibers to decrease electrostatic discharges. Do not use this type of mat to protect yourself from electrical shock.

- Find the room emergency power-off (EPO) switch, disconnecting switch, or electrical outlet. If an electrical accident occurs, you can then operate the switch or unplug the power cord quickly.
- Do not work alone under hazardous conditions or near equipment that has hazardous voltages.
- Disconnect all power before:
 - Performing a mechanical inspection
 - Working near power supplies
 - Removing or installing Field Replaceable Units (FRUs)
- Before you start to work on the machine, unplug the power cord. If you cannot unplug it, ask the customer to power-off the wall box that supplies power to the machine and to lock the wall box in the off position.
- If you need to work on a machine that has exposed electrical circuits, observe the following precautions:
 - Ensure that another person, familiar with the power-off controls, is near you.
Remember: Another person must be there to switch off the power, if necessary.
 - Use only one hand when working with powered-on electrical equipment; keep the other hand in your pocket or behind your back.
Remember: There must be a complete circuit to cause electrical shock. By observing the above rule, you may prevent a current from passing through your body.
 - When using a tester, set the controls correctly and use the approved probe leads and accessories for that tester.
 - Stand on suitable rubber mats (obtained locally, if necessary) to insulate you from grounds such as metal floor strips and machine frames.

Observe the special safety precautions when you work with very high voltages; these instructions are in the safety sections of maintenance information. Use extreme care when measuring high voltages.

- Regularly inspect and maintain your electrical hand tools for safe operational condition.
- Do not use worn or broken tools and testers.
- *Never assume* that power has been disconnected from a circuit. First, *check* that it has been powered-off.
- Always look carefully for possible hazards in your work area. Examples of these hazards are moist floors, nongrounded power extension cables, power surges, and missing safety grounds.
- Do not touch live electrical circuits with the reflective surface of a plastic dental mirror. The surface is conductive; such touching can cause personal injury and machine damage.
- Do not service the following parts with the power on when they are removed from their normal operating places in a machine:

- Power supply units
- Pumps
- Blowers and fans
- Motor generators

and similar units. (This practice ensures correct grounding of the units.)

- If an electrical accident occurs:
 - Use caution; do not become a victim yourself.
 - Switch off power.
 - Send another person to get medical aid.

Safety inspection guide

The intent of this inspection guide is to assist you in identifying potentially unsafe conditions on these products. Each machine, as it was designed and built, had required safety items installed to protect users and service personnel from injury. This guide addresses only those items. However, good judgment should be used to identify potential safety hazards due to attachment of features or options not covered by this inspection guide.

If any unsafe conditions are present, you must determine how serious the apparent hazard could be and whether you can continue without first correcting the problem.

Consider these conditions and the safety hazards they present:

- Electrical hazards, especially primary power (primary voltage on the frame can cause serious or fatal electrical shock).
- Explosive hazards, such as a damaged CRT face or bulging capacitor
- Mechanical hazards, such as loose or missing hardware

The guide consists of a series of steps presented in a checklist. Begin the checks with the power off, and the power cord disconnected.

Checklist:

1. Check exterior covers for damage (loose, broken, or sharp edges).
2. Power-off the computer. Disconnect the power cord.
3. Check the power cord for:
 - a. A third-wire ground connector in good condition. Use a meter to measure third-wire ground continuity for 0.1 ohm or less between the external ground pin and frame ground.
 - b. The power cord should be the appropriate type as specified in the parts listings.
 - c. Insulation must not be frayed or worn.
4. Remove the cover.
5. Check for any obvious alterations. Use good judgment as to the safety of any alterations.
6. Check inside the unit for any obvious unsafe conditions, such as metal filings, contamination, water or other liquids, or signs of fire or smoke damage.
7. Check for worn, frayed, or pinched cables.
8. Check that the power-supply cover fasteners (screws or rivets) have not been removed or tampered with.

Handling electrostatic discharge-sensitive devices

Any computer part containing transistors or integrated circuits (ICs) should be considered sensitive to electrostatic discharge (ESD). ESD damage can occur when there is a difference in charge between objects. Protect against ESD damage by equalizing the charge so that the machine, the part, the work mat, and the person handling the part are all at the same charge.

Notes:

1. Use product-specific ESD procedures when they exceed the requirements noted here.
2. Make sure that the ESD protective devices you use have been certified (ISO 9000) as fully effective.

When handling ESD-sensitive parts:

- Keep the parts in protective packages until they are inserted into the product.
- Avoid contact with other people while handling the part.
- Wear a grounded wrist strap against your skin to eliminate static on your body.
- Prevent the part from touching your clothing. Most clothing is insulative and retains a charge even when you are wearing a wrist strap.
- Use the black side of a grounded work mat to provide a static-free work surface. The mat is especially useful when handling ESD-sensitive devices.
- Select a grounding system, such as those listed below, to provide protection that meets the specific service requirement.

Note: The use of a grounding system is desirable but not required to protect against ESD damage.

- Attach the ESD ground clip to any frame ground, ground braid, or green-wire ground.
- Use an ESD common ground or reference point when working on a double-insulated or battery-operated system. You can use coax or connector-outside shells on these systems.
- Use the round ground-prong of the ac plug on ac-operated computers.

Grounding requirements

Electrical grounding of the computer is required for operator safety and correct system function. Proper grounding of the electrical outlet can be verified by a certified electrician.

Safety notices (multi-lingual translations)

The caution and danger safety notices in this section are provided in the following languages:

- English
- Arabic
- Brazilian/Portuguese
- Chinese (simplified)
- Chinese (traditional)
- French
- German
- Hebrew
- Italian
- Korean

- Spanish



DANGER

Electrical current from power, telephone and communication cables is hazardous.

To avoid a shock hazard:

- Do not connect or disconnect any cables or perform installation, maintenance, or reconfiguration of this product during an electrical storm.
- Connect all power cords to a properly wired and grounded electrical outlet.
- Connect to properly wired outlets any equipment that will be attached to this product.
- When possible, use one hand only to connect or disconnect signal cables.
- Never turn on any equipment when there is evidence of fire, water, or structural damage.
- Disconnect the attached power cords, telecommunications systems, networks, and modems before you open the device covers, unless instructed otherwise in the installation and configuration procedures.
- Connect and disconnect cables as described in the following tables when installing, moving, or opening covers on this product or attached devices.

To Connect	To Disconnect
1. Turn everything OFF. 2. First, attach all cables to devices. 3. Attach signal cables to connectors. 4. Attach power cords to outlet. 5. Turn device ON.	1. Turn everything OFF. 2. First, remove power cords from outlet. 3. Remove signal cables from connectors. 4. Remove all cables from devices.



CAUTION:

If your system has a module containing a lithium battery, replace it only with the same module type made by the same manufacturer. The battery contains lithium and can explode if not properly used, handled, or disposed of. *Do not:*

- Throw or immerse into water
- Heat to more than 100°C (212°F)
- Repair or disassemble

Dispose of the battery as required by local ordinances or regulations.



CAUTION:

When laser products (such as CD-ROMs, DVD-ROM drives, fiber optic devices, or transmitters) are installed, note the following:

- Do not remove the covers. Removing the covers of the laser product could result in exposure to hazardous laser radiation. There are no serviceable parts inside the device.
- Use of controls or adjustments or performance of procedures other than those specified herein might result in hazardous radiation exposure.



DANGER

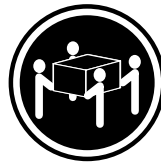
Some laser products contain an embedded Class 3A or Class 3B laser diode. Note the following: Laser radiation when open. Do not stare into the beam, do not view directly with optical instruments, and avoid direct exposure to the beam.



≥18 kg (37 lb)



≥32 kg (70.5 lb)

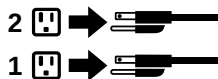


≥55 kg (121.2 lb)

CAUTION:
Use safe practices when lifting.



CAUTION:
The power control button on the device and the power switch on the power supply do not turn off the electrical current supplied to the device. The device also might have more than one power cord. To remove all electrical current from the device, ensure that all power cords are disconnected from the power source.



التيار الكهربائي الموجود بمصدر الطاقة أو أجهزة التليفون أو أسلاك الاتصالات يشكل خطورة.

لتفادي مخاطر الصدمات الكهربائية:

لا تحاول توصيل أو فصل أي أسلاك أو القيام بعمليات تركيب أو صيانة أو إعادة توصيف لهذا المنتج أثناء وجود عاصفة كهربائية.

يجب توصيل كل أسلاك الكهرباء في مخارج كهرباء ذات توصيلات أسلاك وتوصيلات أرضية صحيحة

يجب توصيل أي جهاز سيتم الحاقه بهذا المنتج في مخارج كهرباء ذات توصيلات أسلاك صحيحة.

وإن أمكن يجب استخدام يد واحدة فقط في توصيل أو فصل أسلاك الإشارة.

لا تحاول تشغيل أي جهاز إذا كان هناك أثر لحرق أو مياه أو تلف بالمكونات

يجب فصل أسلاك الكهرباء وأنظمة الاتصالات وشبكات الاتصال وأجهزة المودم الملحقة قبل فتح أغطية الجهاز، مالم يتم طلب خلاف ذلك في التعليمات الخاصة بالتركيب والتوصيف.

قم بتوصيل وفصل الأسلاك كما هو موضح في الجدول التالي وذلك عند القيام بعمليات التركيب أو النقل أو فتح أغطية هذا المنتج أو الأجهزة الملحقة.

للتوصيل:	للفصل:
قم بإيقاف كل شيء.	قم بإيقاف كل شيء.
أولاً، قم بتوصيل كل الأسلاك بالأجهزة.	أولاً، قم بفصل كل أسلاك الكهرباء من المخرج.
قم بتوصيل أسلاك الإشارة في لموصلات.	قم بفصل أسلاك الإشارة من الموصلات.
قم بتوصيل أسلاك الكهرباء في المخارج.	قم بفصل كل الأسلاك من الأجهزة.
قم بتشغيل الجهاز.	



تنبيه :

إذا كان النظام الخاص يستخدم معه بطارية ليثيوم قم باستبدالها بنفس النوع الذي تم صنعته من خلال نفس المصنع. تحتوي البطارية على مادة الليثيوم ويمكن أن تنفجر في حالة عدم استخدامها أو التعامل معها بطريقة صحيحة أو عند التخلص منها بطريقة خطأ.

لا تقم بـ:

- القاء البطارية أو غمرها في الماء
- تسخينها أعلى من ١٠٠ درجة مئوية و(٢١٢ ° فهرنهايت)
- بتصليحها أو فكها

تخلص من البطارية طبقاً للقانون أو النظام المحلي .



تنبيه :

أثناء تركيب منتجات ليزر (مثل CD-ROMs أو وحدة تشغيل DVD أو أجهزة Fiber Optic أو وحدات الإرسال) يجب مراعاة الآتي:

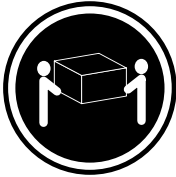
لا تنزع الأغطية. قد ينتج عن نزع أغطية منتج الليزر انفجار أشعة الليزر شديدة الخطورة.
لا يوجد أجزاء يمكن تغييرها داخل الجهاز. قد ينتج عن استخدام تحكمات أو تعديلات أو عمل أي تصرفات أخرى تخالف ما هو محدد هنا إلى انفجار أشعة شديدة الخطورة.



خطر

تحتوي بعض منتجات الليزر على الفئة دايود ليزر مدمج من الفئة Class 3A أو Class 3B. يجب مراعاة الآتي .

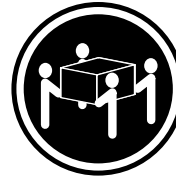
أشعة الليزر عند الفتح. لا تحقق إلى الإشعاع و لا تنظر إليه مباشرة بواسطة أي أجهزة مرئية وتجنب التعرض المباشر للإشعاع .



≥18 kg (37 lb)



≥32 kg (70.5 lb)



≥55 kg (121.2 lb)

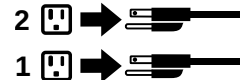
تنبيه :

يجب استخدام ممارسات أمانة عند الرفع



تنبيه :

لا يقر زر التحكم في التشغيل الموجود على الجهاز والمفتاح الكهربائي الموجود على لوحة التحكم بإيقاف التيار الكهربائي المار بالجهاز. قد يكون للجهاز أكثر من سلك كهربائي واحد. لإيقاف التيار الكهربائي المار بالجهاز، تأكد من فصل جميع أسلاك الكهرباء من مصدر الكهرباء .





PERIGO

A corrente elétrica proveniente de cabos de alimentação, de telefone e de comunicações é perigosa.

Para evitar risco de choque elétrico:

- Não conecte nem desconecte nenhum cabo ou execute instalação, manutenção ou reconfiguração deste produto durante uma tempestade com raios.
- Conecte todos os cabos de alimentação a tomadas elétricas corretamente instaladas e aterradas.
- Todo equipamento que for conectado a este produto deve ser conectado a tomadas corretamente instaladas.
- Quando possível, utilize apenas uma das mãos para conectar ou desconectar cabos de sinal.
- Nunca ligue nenhum equipamento quando houver evidência de fogo, água ou danos estruturais.
- Antes de abrir tampas de dispositivos, desconecte cabos de alimentação, sistemas de telecomunicação, redes e modems conectados, a menos que especificado de maneira diferente nos procedimentos de instalação e configuração.
- Conecte e desconecte os cabos conforme descrito na tabela apresentada a seguir ao instalar, mover ou abrir tampas deste produto ou de dispositivos conectados.

Para Conectar:	Para Desconectar:
1. DESLIGUE Tudo. 2. Primeiramente, conecte todos os cabos aos dispositivos. 3. Conecte os cabos de sinal aos conectores. 4. Conecte os cabos de alimentação às tomadas. 5. LIGUE os dispositivos.	1. DESLIGUE Tudo. 2. Primeiramente, remova os cabos de alimentação das tomadas. 3. Remova os cabos de sinal dos conectores. 4. Remova todos os cabos dos dispositivos.



CUIDADO:

Se o seu sistema possui um módulo com uma bateria de lítio, substitua-o apenas por um módulo do mesmo tipo e do mesmo fabricante. A bateria contém lítio e pode explodir se não for utilizada, manuseada ou descartada de maneira correta.

Não:

- Jogue ou coloque na água
- Aqueça a mais de 100°C (212°F)
- Conserte nem desmonte

Descarte a bateria conforme requerido pelas leis ou regulamentos locais.



PRECAUCIÓN:

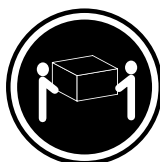
Quando produtos a laser (como unidades de CD-ROMs, unidades de DVD-ROM, dispositivos de fibra ótica ou transmissores) estiverem instalados, observe o seguinte:

- Não remova as tampas. A remoção das tampas de um produto a laser pode resultar em exposição prejudicial à radiação de laser. Não existem peças que podem ser consertadas no interior do dispositivo.
- A utilização de controles ou ajustes ou a execução de procedimentos diferentes dos especificados aqui pode resultar em exposição prejudicial à radiação.

PERIGO

Alguns produtos a laser contêm diodo de laser integrado da Classe 3A ou da Classe 3B. Observe o seguinte:

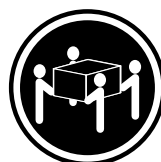
Radiação a laser quando aberto. Não olhe diretamente para o feixe a olho nu ou com instrumentos ópticos e evite exposição direta ao feixe.



≥18 kg (37 lb)



≥32 kg (70.5 lb)



≥55 kg (121.2 lb)

CUIDADO:

Utilize procedimentos de segurança para levantar equipamentos.



CUIDADO:

O botão de controle de alimentação do dispositivo e o botão para ligar/desligar da fonte de alimentação não desligam a corrente elétrica fornecida ao dispositivo. O dispositivo também pode ter mais de um cabo de alimentação. Para remover toda a corrente elétrica do dispositivo, assegure que todos os cabos de alimentação estejam desconectados da fonte de alimentação.



危险

电源、电话和通信电缆中的电流是危险的。

为避免电击危险：

- 请勿在雷电期间连接或断开任何电缆的连接，或者对本产品进行安装、维护或重新配置。
- 将所有电源线连接到正确连线和妥善接地的电源插座。
- 将所有要连接到该产品的设备连接到正确连线的插座。
- 如果可能，请仅使用一只手来连接或断开信号电缆的连接。
- 切勿在有火、水、结构损坏迹象的情况下开启任何设备。
- 在打开设备外盖之前请断开已连接的电源线、远程通信系统、网络和调制解调器，除非在安装和配置过程中另有说明。
- 当安装、移动或打开该产品或连接设备的外盖时，请按照下表所述来连接或断开电缆的连接。

要连接	要断开连接
1. 切断所有电源。 2. 首先将所有电缆连接到设备。 3. 将信号电缆连接到接口。 4. 将电源线连接到插座。 5. 开启设备。	1. 切断所有电源。 2. 首先从插座上拔出电源线。 3. 从接口上拔出信号电缆。 4. 从设备上拔出所有电缆。



警告：
如果您的系统有包含锂电池的模块，请仅使用同一制造商生产的相同模块类型来替换该模块。
该电池中含有锂，如果使用、操作或处理不当，可能会发生爆炸。

切勿：

- 投入或浸入水中
- 加热到 100 °C (212 °F) 以上
- 维修或拆卸

请按照当地法令或条例的要求处理电池。



警告：
安装激光产品（例如 CD-ROM、DVD-ROM 驱动器、光纤设备或发射设备）时，
请注意以下声明：

- 请勿卸下外盖。卸下激光产品的外盖可能导致遭受激光辐射的危险。该设备内没有可维修的部件。
- 如果不按照此处指定的过程进行控制、调整或操作，则有可能导致遭受辐射的危险。



危险

某些激光产品包含嵌入式 3A 类或 3B 类激光二极管。请注意以下声明：

打开后有激光辐射。请勿注视光束，请勿直接用光学仪器查看，并请避免直接暴露在光束中。

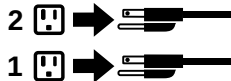


≥18 千克 (37 磅) ≥32 千克 (70.5 磅) ≥55 千克 (121.2 磅)

警告：
抬起时请采取安全措施。



警告：
设备上的电源控制按钮和电源上的电源开关不会切断供给该设备的电流。该设备还可能有多条电源线。要切断该设备的所有电流，请确保所有电源线都与电源断开连接。



危險

電源、電話及通訊纜線上的電流都具有危險性。

若要避免觸電危險：

- 請勿在雷雨期間，連接或拔除纜線、執行安裝、維護或重新配置本產品。
- 將所有電源線連接到正確配線及接地的電源插座。
- 任何與本產品連接的設備都必須連接到配線妥當的電源插座。
- 請盡可能用單手連接或拔除信號線。
- 發生火災、水災或結構損害時，絕對不要開啟任何設備。
- 除非在安裝及配置程序中另有指示，否則在開啟裝置機蓋之前，請拔掉連接的電源線、電信系統、網路及數據機。
- 安裝、移動或開啟本產品或附屬裝置的機蓋時，請遵循下列說明連接及拔掉纜線。

連線	切斷連線
1. 關閉所有開關。 2. 首先，連接所有接線到裝置。 3. 連接信號線到接頭。 4. 連接電源線到插座。 5. 開啟裝置。	1. 關閉所有開關。 2. 首先，拔掉插座上的電源線。 3. 拔掉接頭上的信號線。 4. 拔掉裝置上所有接線。



警告：

如果您的系統中含有鋰電池模組，請僅使用同一家製造商所生產的相同模組進行更換。

如果未以正確方式使用、處理或棄置含鋰的電池，會有爆炸的危險。

請勿：

- 沾溼或浸入水中
- 置於 **100°C (212°F)** 以上的高溫環境
- 修理或拆開

請按照各地區有關廢棄電池的法令和規定處理舊電池。



警告：

- 請勿移除機蓋。移除雷射產品的機蓋，可能會導致暴露在危險的雷射輻射中。裝置內部並無可自行維修的零件。
- 利用或執行非本文中所指定的控制、調整及執行程序，可能會導致危險的輻射外洩。

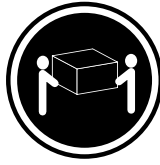


危險

部分雷射產品含有內嵌式 **Class 3A** 或 **Class 3B** 雷射二極體。請注意下列事項：

在開啟光碟機時，會發生雷射輻射。請勿直視光束或用光學儀器直接檢視，並避免直接暴露在光束中。



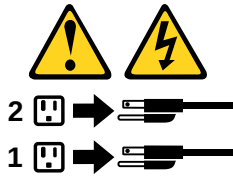


≥ 18 公斤 (37 磅) ≥ 32 公斤 (70.5 磅) ≥ 55 公斤 (121.2 磅)

警告：
搬運時請注意安全。



警告：
裝置上的電源控制按鈕及電源供應器上的電源開關，無法關閉裝置所產生的電流。
該裝置可能有多條電源線。若要除去裝置流出的所有電流，請確認已切斷所有電源線的電源。



DANGER

Le courant électrique provenant de l'alimentation, du téléphone et des câbles de transmission peut présenter un danger.

Pour éviter tout risque de choc électrique :

- Ne manipulez aucun câble et n'effectuez aucune opération d'installation, d'entretien ou de reconfiguration de ce produit au cours d'un orage.
- Branchez tous les cordons d'alimentation sur un socle de prise de courant correctement câblé et mis à la terre.
- Branchez sur des socles de prise de courant correctement câblés tout équipement connecté à ce produit.
- Lorsque cela est possible, n'utilisez qu'une seule main pour connecter ou déconnecter les câbles d'interface.
- Ne mettez jamais un équipement sous tension en cas d'incendie ou d'inondation, ou en présence de dommages matériels.
- Avant de retirer les carters de l'unité, mettez celle-ci hors tension et déconnectez ses cordons d'alimentation, ainsi que les câbles qui la relient aux réseaux, aux systèmes de télécommunication et aux modems (sauf instruction contraire mentionnée dans les procédures d'installation et de configuration).
- Lorsque vous installez, que vous déplacez, ou que vous manipulez le présent produit ou des périphériques qui lui sont raccordés, reportez-vous aux instructions ci-dessous pour connecter et déconnecter les différents cordons.

Connexion	Déconnexion
1. Mettez les unités HORS TENSION. 2. Commencez par brancher tous les cordons sur les unités. 3. Branchez les câbles d'interface sur des connecteurs. 4. Branchez les cordons d'alimentation sur des prises. 5. Mettez les unités SOUS TENSION.	1. Mettez les unités HORS TENSION. 2. Débranchez les cordons d'alimentation des prises. 3. Débranchez les câbles d'interface des connecteurs. 4. Débranchez tous les câbles des unités.



ATTENTION:

Si votre système est doté d'un module contenant une pile au lithium, vous devez le remplacer uniquement par un module identique, produit par le même fabricant. La pile contient du lithium et peut exploser en cas de mauvaise utilisation, de mauvaise manipulation ou de mise au rebut inappropriée.

Ne pas :

- la jeter à l'eau,
- l'exposer à des températures supérieures à 100°C,
- chercher à la réparer ou à la démonter.

Ne pas mettre la pile à la poubelle. Pour la mise au rebut, se reporter à la réglementation en vigueur.



ATTENTION:

Si des produits à laser (tels que des unités de CD-ROM, de DVD-ROM, des unités à fibres optiques, ou des émetteurs) sont installés, prenez connaissance des informations suivantes :

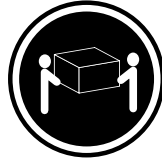
- Ne retirez pas le carter. En ouvrant l'unité de CD-ROM ou de DVD-ROM, vous vous exposez au rayonnement dangereux du laser. Aucune pièce de l'unité n'est réparable.
- Pour éviter tout risque d'exposition au rayon laser, respectez les consignes de réglage et d'utilisation des commandes, ainsi que les procédures décrites dans le présent manuel.



DANGER

Certains produits à laser contiennent une diode à laser intégrée de classe 3A ou 3B. Prenez connaissance des informations suivantes:

Rayonnement laser lorsque le carter est ouvert. Evitez toute exposition directe au rayon laser. Evitez de regarder fixement le faisceau ou de l'observer à l'aide d'instruments optiques.



≥18 kg (37 lb)



≥32 kg (70.5 lb)



≥55 kg (121.2 lb)

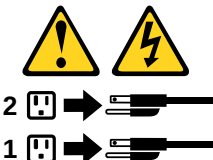
ATTENTION:

Soulevez la machine avec précaution.



ATTENTION:

L'interrupteur de contrôle d'alimentation de l'unité et l'interrupteur dubloc d'alimentation ne coupent pas le courant électrique alimentant l'unité. En outre, le système peut être équipé de plusieurs cordons d'alimentation. Pour mettre l'unité hors tension, vous devez déconnecter tous les cordons de la source d'alimentation.



VORSICHT

An Netz-, Telefon- und Datenleitungen können gefährliche Spannungen anliegen.

Aus Sicherheitsgründen:

- Bei Gewitter an diesem Gerät keine Kabel anschließen oder lösen. Ferner keine Installations-, Wartungs- oder Rekonfigurationsarbeiten durchführen.
- Gerät nur an eine Schutzkontaktsteckdose mit ordnungsgemäß geerdetem Schutzkontakt anschließen.
- Alle angeschlossenen Geräte ebenfalls an Schutzkontaktsteckdosen mit ordnungsgemäß geerdetem Schutzkontakt anschließen.
- Die Signalkabel nach Möglichkeit einhändig anschließen oder lösen, um einen Stromschlag durch Berühren von Oberflächen mit unterschiedlichem elektrischem Potenzial zu vermeiden.

- Geräte niemals einschalten, wenn Hinweise auf Feuer, Wasser oder Gebäudeschäden vorliegen.
- Die Verbindung zu den angeschlossenen Netzkabeln, Telekommunikationssystemen, Netzwerken und Modems ist vor dem Öffnen des Gehäuses zu unterbrechen, sofern in den Installations- und Konfigurationsprozeduren keine anders lautenden Anweisungen enthalten sind.
- Zum Installieren, Transportieren und Öffnen der Abdeckungen des Computers oder der angeschlossenen Einheiten die Kabel gemäß der folgenden Tabelle anschließen und abziehen.

Zum Anschließen der Kabel gehen Sie wie folgt vor	Zum Abziehen der Kabel gehen Sie wie folgt vor
1. Schalten Sie alle Einheiten AUS. 2. Schließen Sie erst alle Kabel an die Einheiten an. 3. Schließen Sie die Signalkabel an die Buchsen an. 4. Schließen Sie die Netzkabel an die Steckdose an. 5. Schalten Sie die Einheit EIN.	1. Schalten Sie alle Einheiten AUS. 2. Ziehen Sie zuerst alle Netzkabel aus den Netzsteckdosen. 3. Ziehen Sie die Signalkabel aus den Buchsen. 4. Ziehen Sie alle Kabel von den Einheiten ab.



CAUTION:

Enthält das System ein Modul mit einer Lithiumbatterie, dieses nur durch ein Modul desselben Typs und von demselben Hersteller ersetzen. Die Batterie enthält Lithium und kann bei unsachgemäßer Verwendung, Handhabung oder Entsorgung explodieren.

Die Batterie nicht:

- mit Wasser in Berührung bringen.
- über 100 °C erhitzen.
- reparieren oder zerlegen.

Die örtlichen Bestimmungen für die Entsorgung von Sondermüll beachten.



ACHTUNG:

Bei der Installation von Lasergeräten (wie CD-ROM-Laufwerken, DVD- aufwerken, Einheiten mit Lichtwellenleitertechnik oder Sendern) Folgendes beachten:

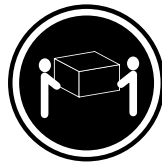
- Die Abdeckungen nicht entfernen. Durch Entfernen der Abdeckungen des Lasergeräts können gefährliche Laserstrahlungen freigesetzt werden. Das Gerät enthält keine zu wartenden Teile.
- Werden Steuerelemente, Einstellungen oder Durchführungen von Prozeduren anders als hier angegeben verwendet, kann gefährliche Laserstrahlung auftreten.



VORSICHT

Einige Lasergeräte enthalten eine Laserdiode der Klasse 3A oder 3B. Beachten Sie Folgendes:

Laserstrahlung bei geöffneter Verkleidung. Nicht in den Strahl blicken. Keine Lupen oder Spiegel verwenden. Strahlungsbereich meiden.



≥18 kg



≥32 kg



≥55 kg

ACHTUNG:

Arbeitsschutzrichtlinien beim Anheben der Maschine beachten.



ACHTUNG:

Mit dem Netzschalter an der Einheit und am Netzteil wird die Stromversorgung für die Einheit nicht unterbrochen. Die Einheit kann auch mit mehreren Netzkabeln ausgestattet sein. Um die Stromversorgung für die Einheit vollständig zu unterbrechen, müssen alle zum Gerät führenden Netzkabel vom Netz getrennt werden.



סכנה

זרם חשמלי המועבר בכבלי חשמל, טלפון ותקשורת הוא מסוכן.

כדי להימנע מסכנת התחשמלות:

- אל תחברו או תנתקו כבלים, ואל תבצעו פעולת התקנה, תחזוקה או שינוי תצורה במוצר זה במהלך סופת ברקים.
- חברו את כל כבלי החשמל לשקע חשמל מחווט ומוארק כהלכה.
- חברו כל ציוד שיחובר למוצר זה לשקעי חשמל מחוטים כהלכה.
- במידת האפשר, השתמשו ביד אחת בלבד לחיבור או לניתוק של כבלי אותות.
- לעולם אל תפעילו ציוד כלשהו כאשר יש עדות לנזק מבני או לנזק כתוצאה מאש או ממים.
- נתקו את כבלי החשמל, מערכות התקשורת, התקני הרשת והמודמים המחוברים לפני פתיחת כיסויי ההתקן, אלא אם הליכי ההתקנה וקביעת התצורה מורים אחרת.
- בעת התקנה, העברה או פתיחת כיסויים במוצר זה או בהתקנים המחוברים, חברו ונתקו את הכבלים כמתואר בטבלה שלהלן.

כדי לחבר	כדי לנתק
1. כבו הכל.	1. כבו הכל.
2. ראשית, חברו את כל הכבלים להתקנים.	2. ראשית, נתקו את כבלי החשמל מהשקעים.
3. חברו את כבלי האותות למחברים.	3. נתקו את כבלי האותות מהמחברים.
4. חברו את כבלי החשמל לשקעים.	4. הסירו את כל הכבלים מההתקנים.
5. הפעילו את ההתקן.	



זהירות:

אם המערכת כוללת מודול המכיל סוללת ליתיום, החליפו אותו רק במודול מאותו סוג ומתוצרת אותו יצרן. הסוללה מכילה ליתיום, ועלולה להתפוצץ אם לא משתמשים ומטפלים בה או משליכים אותה כיאות.

לעולם:

- אל תטבלו במים

- אל תחממו לטמפרטורה הגבוהה מ-100°C (212°F)

- אל תתקנו או תפרקו

השליכו את הסוללה כנדרש לפי התקנות והחוקים המקומיים.



זהירות:

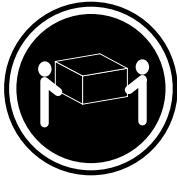
בעת התקנת מוצרי ליזר (כגון כונני תקליטורים ו-DVD, התקני סיב אופטי או משדרים), שימו לב לאזהרות הבאות:

- אל תסירו את הכיסויים. הסרת הכיסויים של מוצר הלייזר עלולה לגרום לחשיפה לקרינת לייזר מסוכנת. אין חלקים ברי טיפול בתוך ההתקן.
- שינויים, שימוש בבקורות או ביצוע הליכים אחרים מאלה המתוארים כאן, עלולים לגרום לחשיפה לקרינה מסוכנת.



סכנה

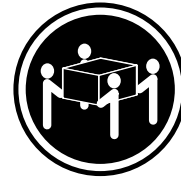
מוצרי ליזר מסוימים מכילים דיודת ליזר מסוג Class 3A או Class 3B. שימו לב לאזהרה הבאה:
כאשר הוא פתוח, המוצר פולט קרינת ליזר. אל תביטו ישירות בקרן, אל תביטו ישירות בעזרת ציוד אופטי,
והימנעו מחשיפה לקרן.



≤ 18 ק"ג (37 ליב')



≤ 32 ק"ג (70.5 ליב')



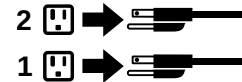
≤ 55 ק"ג (121.2 ליב')

זהירות:
השתמשו בהליכים
הנאותים בעת
הרמת הציוד.



זהירות:

לחצן ההפעלה של ההתקן ומתג ההפעלה של ספק החשמל אינם מפסיקים את זרם החשמל המסופק להתקן.
בנוסף, ההתקן עשוי לכלול יותר מכבל חשמל אחד. כדי לסלק את כל הזרם החשמלי מההתקן,
ודאו שכל כבלי החשמל מנותקים ממקור החשמל.



PERICOLO

La corrente elettrica proveniente dai cavi di alimentazione, del telefono e di comunicazione può essere pericolosa.

Per evitare il rischio di scosse elettriche:

- **Non collegare o scollegare qualsiasi cavo oppure effettuare l'installazione, la manutenzione o la riconfigurazione del prodotto durante un temporale.**
- **Collegare tutti i fili elettrici a una presa di alimentazione correttamente cablata e dotata di messa a terra.**
- **Collegare alle prese elettriche appropriate tutte le apparecchiature che verranno utilizzate per questo prodotto.**
- **Se possibile, utilizzare solo una mano per collegare o scollegare i cavi di segnale.**
- **Non accendere assolutamente apparecchiature in presenza di incendi, perdite d'acqua o danno strutturale.**
- **Scollegare i cavi di alimentazione, i sistemi di telecomunicazione, le reti e il modem prima di aprire i coperchi del dispositivo, salvo istruzioni contrarie relative alle procedure di installazione e configurazione.**
- **Collegare e scollegare i cavi come descritto nella seguente tabella quando vengono effettuate operazioni di installazione, spostamento o apertura dei coperchi di questo prodotto o delle unità collegate.**

Per collegarsi	Per scollegarsi
1. SPEGNERE le apparecchiature. 2. Innanzitutto, collegare tutti i cavi alle unità. 3. Collegare i cavi di segnale ai connettori. 4. Collegare i cavi di alimentazione alla presa. 5. Accendere l'unità.	1. SPEGNERE le apparecchiature. 2. Innanzitutto, rimuovere i cavi di alimentazione dalla presa. 3. Rimuovere i cavi di segnale dai connettori. 4. Rimuovere tutti i cavi dalle unità.



ATTENZIONE:

Se sul sistema è presente un modulo che contiene una batteria al litio, sostituirlo solo con un tipo di modulo dello stesso tipo della stessa casa di produzione. La batteria contiene litio e può esplodere se usata, maneggiata o smaltita in modo non corretto.

Non:

- **Gettare o immergere la batteria nell'acqua**
- **Riscaldarla ad una temperatura superiore ai 100 gradi C (212 gradi F)**
- **Smontarla, ricaricarla o tentare di ripararla**

Le batterie usate vanno smaltite in accordo alla normativa in vigore (DPR 915/82 e successive disposizioni e disposizioni locali).



ATTENZIONE:

Quando vengono installati prodotti laser (quali CD-ROM, unità DVD-ROM, unità a fibre ottiche o trasmettenti), tener presente quanto segue:

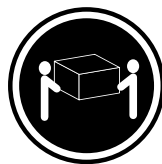
- Non rimuovere gli sportelli. L'apertura di un'unità laser può determinare l'esposizione a radiazioni laser pericolose. All'interno dell'unità non vi sono parti su cui effettuare l'assistenza tecnica.
- L'utilizzo di controlli, regolazioni o l'esecuzione di procedure non descritti nel presente manuale possono provocare l'esposizione a radiazioni pericolose.



PERICOLO

Alcune unità laser contengono un diodo laser di Classe 3A o Classe 3B. Tener presente quanto segue:

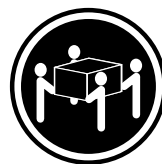
Aprendo l'unità vengono emesse radiazioni laser. Non fissare il fascio, non guardarlo direttamente con strumenti ottici ed evitare l'esposizione al fascio.



≥18 kg



≥32 kg



≥55 kg

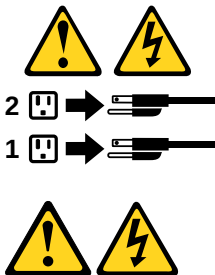
ATTENZIONE:

Prestare attenzione nel sollevare l'apparecchiatura.



ATTENZIONE:

Il pulsante di controllo dell'alimentazione presente sull'unità e l'interruttore dell'alimentatore non disattivano l'alimentazione corrente fornita all'unità. E' possibile che l'unità disponga di più cavi di alimentazione. Per disattivare l'alimentazione dall'unità, accertarsi che tutti i cavi di alimentazione siano scollegati dalla fonte di alimentazione.



위험

전원, 전화, 통신 케이블의 전류는 위험합니다.

감전의 위험을 피하려면 다음과 같이 하십시오.

- 번개가 치는 날에는 케이블을 연결 또는 분리하거나 본 제품을 설치, 보수, 재구성하지 마십시오.
- 모든 전원 코드는 올바르게 접지된 전기 콘센트에 연결하십시오.
- 본 제품에 연결될 장치는 올바르게 배선된 콘센트에 연결하십시오.
- 신호 케이블을 연결 또는 분리할 때 가능하면 한 손만을 사용하십시오.
- 불 또는 물로 인한 손상이나 구조적인 손상이 있을 경우 장치의 전원을 절대 켜지 마십시오.
- 설치 및 구성 과정에 별도의 지시 사항이 없는 경우, 장치의 덮개를 열기 전에 연결된 전원 코드, 원격 통신 시스템, 네트워크, 모뎀을 분리하십시오.
- 본 제품이나 연결된 장치를 설치, 이동하거나 덮개를 열 때 다음 표와 같은 순서로 케이블을 연결하거나 분리하십시오.

연결할 때:	분리할 때:
1. 모든 장치의 전원을 끄십시오. 2. 먼저 모든 케이블을 장치에 연결하십시오. 3. 커넥터에 신호 케이블을 연결하십시오. 4. 콘센트에 전원 코드를 연결하십시오. 5. 장치의 전원을 켜십시오.	1. 모든 장치의 전원을 끄십시오. 2. 먼저 콘센트에서 전원 코드를 분리하십시오. 3. 커넥터에서 신호 케이블을 분리하십시오. 4. 장치에서 모든 케이블을 분리하십시오.



주의:

사용자의 시스템이 리튬 배터리를 포함하는 모듈일 경우, 동일한 제조업체에서 동일한 모듈 유형으로 생산된 제품으로 교체하십시오. 배터리에는 리튬이 함유되어 있어 잘못 사용, 취급 또는 폐기할 경우 폭발의 위험이 있습니다.

사고를 방지하려면 다음 사항을 준수하십시오.

- 배터리를 물 속에 던지거나 침수시키지 마십시오.
- 100℃ (212°F) 이상 가열하지 마십시오.
- 수리하거나 분해하지 마십시오.

배터리를 폐기할 때는 법령 또는 회사의 안전 수칙에 따라 폐기하십시오.



주의:

CD-ROM, DVD-ROM 장치, 광섬유 장치 또는 송신 장치와 같은 레이저 제품을 설치할 때, 다음과 같은 취급 주의사항을 참고하십시오.

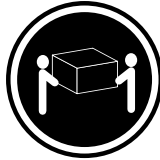
- 덮개를 열지 마십시오. 덮개를 열면 레이저 복사 에너지에 노출될 위험이 있습니다. 장치 내부에는 사용자가 조정하거나 수리할 수 있는 부품이 없습니다.
- 규정된 것 이외의 절차 수행, 제어 조정 등의 행위로 인해 해로운 레이저 복사에 노출될 수 있습니다.



위험

일부 장비에는 임베디드 클래스 3A 또는 클래스 3B 레이저 다이오드가 있습니다. 다음 주의사항에 유의하십시오.

드라이브가 열리면 레이저 복사 에너지가 방출됩니다. 광선이 눈에 직접 쏘이지 않도록 하십시오. 나안 또는 광학 기구를 착용한 상태에서 광선을 직접 바라보지 않도록 하십시오.



≥ 18 kg (37 lbs)



≥ 32 kg (70.5 lbs)

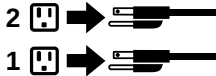


≥ 55 kg (121.2 lbs)

주의:
제품을 들어 올릴 때
안전 규제를 따르십시오.



주의:
장치의 전원 제어 버튼 및 전원 공급 장치의 전원 스위치를 사용하여 장치에 공급되는 전기를 차단하지 마십시오.
장치는 둘 이상의 코드를 가지고 있을 수 있습니다. 장치에서 모든 전원을 차단하려면 콘센트에서 코드가 모두
분리되어 있는지 확인하십시오.



PELIGRO

La corriente eléctrica procedente de cables de alimentación, teléfonos y cables de comunicación puede ser peligrosa.

Para evitar el riesgo de descarga eléctrica:

- No conecte ni desconecte los cables ni realice ninguna tarea de instalación, mantenimiento o reconfiguración de este producto durante una tormenta eléctrica.
- Conecte todos los cables de alimentación a tomas de corriente debidamente cableadas y conectadas a tierra.
- Cualquier equipo que se conecte a este producto también debe conectarse a tomas de corriente debidamente cableadas.

- Siempre que sea posible, utilice una sola mano para conectar o desconectar los cables de señal.
- No encienda nunca un equipo cuando hay señales de fuego, agua o daños estructurales.
- Desconecte los cables de alimentación, los sistemas de telecomunicaciones, las redes y los módems conectados antes de abrir las cubiertas de los dispositivos, a menos que se indique lo contrario en los procedimientos de instalación y configuración.
- Conecte y desconecte los cables, como se describe en la tabla siguiente, cuando instale, mueva o abra las cubiertas de este producto o de los dispositivos conectados.

Para conectar	Para desconectar
1. APÁGUELO todo. 2. En primer lugar, conecte todos los cables a los dispositivos. 3. Conecte los cables de señal a los conectores. 4. Enchufe los cables de alimentación a las tomas de corriente. 5. Encienda el dispositivo.	1. APÁGUELO todo. 2. En primer lugar, desenchufe los cables de alimentación de las tomas de corriente. 3. Desconecte los cables de señal de los conectores. 4. Desconecte todos los cables de los dispositivos.



PRECAUCIÓN:

Si su sistema dispone de un módulo que contiene una batería de litio, reemplácelo sólo con el mismo tipo de módulo, del mismo fabricante. La batería contiene litio y puede explotar si no se utiliza, manipula o desecha correctamente.

No debe:

- Arrojarla al agua o sumergirla en ella
- Exponerla a temperaturas superiores a 100°C (212°F)
- Repararla o desmontarla

Deshágase de la batería según especifiquen las leyes o normas locales.



PRECAUCIÓN:

Cuando haya productos láser (como unidades de CD-ROM, unidades de DVD, dispositivos de fibra óptica o transmisores) instalados, tenga en cuenta lo siguiente:

- No quite las cubiertas. Si quita las cubiertas del producto láser, podría quedar expuesto a radiación láser peligrosa. Dentro del dispositivo no existe ninguna pieza que requiera servicio técnico.
- Si usa controles o ajustes o realiza procedimientos que no sean los especificados aquí, podría exponerse a radiaciones peligrosas.



PELIGRO

Algunos productos láser tienen incorporado un diodo láser de clase 3A o clase 3B. Tenga en cuenta lo siguiente:

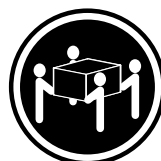
Cuando se abre, queda expuesto a radiación láser. No mire directamente al rayo láser, ni siquiera con instrumentos ópticos, y evite exponerse directamente al rayo láser.



≥18 kg



≥32 kg



≥55 kg

PRECAUCIÓN:

Adopte procedimientos seguros al levantar el equipo.



PRECAUCIÓN:

El botón de control de alimentación del dispositivo y el interruptor de alimentación de la fuente de alimentación no desconectan la corriente eléctrica suministrada al dispositivo. Además, el dispositivo podría tener más de un cable de alimentación. Para suprimir toda la corriente eléctrica del dispositivo, asegúrese de que todos los cables de alimentación estén desconectados de la toma de corriente.



Chapter 2. Important service information

Strategy for replacing FRUs

Before replacing parts:

Ensure that all software fixes, drivers, and UEFI BIOS downloads are installed before you replace any FRUs listed in this manual.

After a system board is replaced, ensure that the latest UEFI BIOS is loaded to the system board before you complete the service action.

To download and install software fixes, drivers, and UEFI BIOS, go to <https://pcsupport.lenovo.com> and follow the instructions on the screen.

Use the following strategy to prevent unnecessary expense for replacing and servicing FRUs:

- If you are instructed to replace a FRU but the replacement does not correct the problem, reinstall the original FRU before you continue.
- Some computers have both a processor board and a system board. If you are instructed to replace either the processor board or the system board, and replacing one of them does not correct the problem, reinstall that board, and then replace the other one.
- If an adapter or a device consists of more than one FRU, any of the FRUs might be the cause of the error. Before replacing the adapter or device, remove the FRUs, one by one, to see if the symptoms change. Replace only the FRU that changed the symptoms.

Strategy for replacing a hard disk drive or a solid-state drive

Always try to run a low-level format operation before replacing a hard disk drive or a solid-state drive. This will cause all customer data on the drive to be lost. Ensure that the customer has a current backup of the data before you perform this task.

Attention: The drive startup sequence in the computer you are servicing might have been changed. Be extremely careful during write operations such as copying, saving, or formatting. If you select an incorrect drive, data or programs can be overwritten.

Important notice for replacing a system board

Some components mounted on a system board are very sensitive. Improper handling of a system board can cause damage to those components, and may cause a system malfunction.

After replacing the system board, the recommended option is to download the latest UEFI BIOS package from Lenovo Support Web site to bind the model type, serial number, and brand ID of the computer with the new system board. Or use Golden Key U1 tool to bind the new system board. Refer to <https://support.lenovo.com/solutions/ht102004> for instructions.

Attention: When handling a system board:

- Do not drop a system board or apply any excessive force to it.
- Avoid rough handling of any kind.
- Avoid bending a system board and hard pushing to prevent cracking at each Ball Grid Array (BGA) chipset.

How to use error codes

Use the error codes displayed on the screen to diagnose failures. If more than one error code is displayed, begin the diagnosis with the first error code. Whatever causes the first error code might also cause false error codes. If no error code is displayed, see whether the error symptom is listed in the “Symptom-to-FRU Index” section.

Strategy for replacing FRUs for CTO, special-bid, and standard models

This topic provides information about the model types and FRU identification.

Product definition

This topic introduces different model types and how to identify each type.

Dynamic Configure To Order (CTO) model

This model provides the ability for a customer to configure a Lenovo solution from a Web site, and have this configuration sent to fulfillment, where it is built and shipped directly to the customer. The machine label and eSupport will load these products as the 4-character MT, 4-character model, and 2-character country code. The model is “CTO1” and the default country code is “WW” (example: 20AACTO1WW).

Special-bid model

This model is a unique configuration that has been negotiated between Lenovo and the customer. A unique MTM consists of a 4-character MT, a 4-character model, and a numeric 2-character country code is provided to the customer to place orders (example: 20AA000955). The country code assigned is numeric and does not designate a specific country or region. The custom model factsheet for the MTM indicates which country the special-bid MTM is set up for. Special-bid offering is not generally announced.

Standard model

Standard models (fixed configuration) are announced and offered to all customers. The MTM portion of the machine label consists of a 4-character MT, a 4-character model, and an alphabetic 2-character country code. The country code assigned is alphabetic and represents a designated country or region (example: 20AA0009UK).

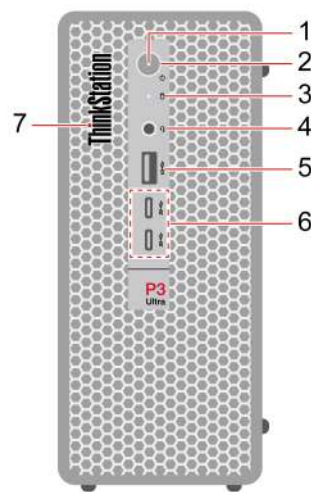
FRU identification

To identify FRUs for a product, do the following:

1. Go to: <https://support.lenovo.com/partslookup>.
2. Type the Machine Type in the corresponding field to get a general FRU list, or type the Serial Number for more detailed FRU information.

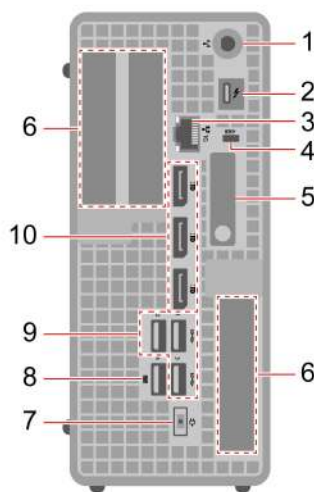
Chapter 3. Product overview

Front



Item	Description	Item	Description
1	Power indicator	2	Power button
3	Storage drive activity indicator	4	Headset connector
5	USB-A connector (USB 10Gbps)	6	USB-C® connectors (USB 20Gbps)
7	ThinkStation LED		

Rear



Item	Description	Item	Description
1	Wi-Fi® antenna slot	2	USB-C connector (Thunderbolt™ 4)*
3	Ethernet connector (1 GbE)	4	Security-lock slot
5	Chassis latch	6	PCI-Express card area
7	Power cord connector	8	USB-A connector (USB 10Gbps, smart power on)
9	USB-A connector (USB 10Gbps)	10	DisplayPort™ out connectors

* for selected models

Chapter 4. Service checkout and symptom-to-FRU index

This chapter provides information about general service checkout and symptom-to-FRU index.

Service checkout

Attention: The drives in the computer you are servicing might have been rearranged or the drive startup sequence changed. Be extremely careful during write operations such as copying, saving, or formatting. Data or programs can be overwritten if you select an incorrect drive.

General error messages appear if a problem or conflict is found by a program, the operating system, or both. For an explanation of these messages, refer to the information supplied with that software package.

Use the following procedure to help determine the cause of the problem:

1. Turn off the computer and all external devices.
2. Check all cables and power cords.
3. Set all display controls to the middle position.
4. Turn on all external devices.
5. Turn on the computer.
 - Look for displayed error codes.
 - Listen for beep codes.
 - Look for readable instructions or a main menu on the display.

If you *did not* receive the correct response, proceed to step 6 on page 31.

If you *do* receive the correct response, proceed to step 7 on page 31.

6. Look at the following conditions and follow the instructions:
 - If you hear beep codes during POST, go to “Beep symptoms” on page 33.
 - If the computer displays a POST error, go to “POST error codes” on page 34.
 - If the computer hangs and no error is displayed, continue at step 7 on page 31.
7. Run the Diagnostic programs. See Chapter 6 “Diagnostics” on page 41.
 - If you receive an error, replace the part that the diagnostic program calls out.
 - If the test stops and you cannot continue, replace the last device tested.

Problem determination tips

Due to the variety of hardware and software combinations that can be encountered, use the following information to assist you in problem determination. If possible, have this information available when requesting assistance from Service Support and Engineering functions.

- Machine type and model
- Processor or hard disk drive upgrades
- Failure symptom
 - Do diagnostics indicate a failure?
 - What, when, where, single, or multiple systems?
 - Is the failure repeatable?
 - Has this configuration ever worked?

- If it has been working, what changes were made prior to its failing?
- Is this the original reported failure?
- Diagnostics version
 - Type and version level
- Hardware configuration
 - Print (print screen) configuration currently in use
 - BIOS level
- Operating system software
 - Type and version level

Notes: To eliminate confusion, identical systems are considered identical only if they:

1. Are the exact machine type and models
2. Have the same BIOS level
3. Have the same adapters/attachments in the same locations
4. Have the same address jumpers/terminators/cabling
5. Have the same software versions and levels
6. Have the same Diagnostic Diskettes (version)
7. Have the same configuration options set in the system
8. Have the same setup for the operating system control files

Comparing the configuration and software set-up between “working and non-working” systems will often lead to problem resolution.

Symptom-to-FRU index

The Symptom-to-FRU index lists error symptoms and possible causes. The most likely cause is listed first. Always begin with “Service checkout” on page 31. This index can also be used to help you decide which FRUs to have available when servicing a computer. If you are unable to correct the problem using this index, go to “Undetermined problems” on page 37.

Notes:

- The Symptom-to-FRU index is not specific to any machine type and are applicable to all computers.
- If you have both an error message and an incorrect audio response, diagnose the error message first.
- If you cannot run the diagnostic tests or you get a diagnostic error code when running a test, but did receive a POST error message, diagnose the POST error message first.
- If you did not receive any error message, look for a description of your error symptoms in the first part of this index.

Hard disk drive boot error

A hard disk drive boot error can have the following causes.

Error	FRU/Action
The start-up drive is not in the boot sequence in configuration.	Check the configuration and ensure that the start-up drive is in the boot sequence.
No operating system installed on the boot drive.	Install an operating system on the boot drive.

Error	FRU/Action
The boot sector on the startup drive is corrupted.	The drive must be formatted. Do the following: 1. Attempt to back up the data on the failing hard disk drive. 2. Using the operating system programs, format the hard disk drive.
The drive is defective.	Replace the hard disk drive.

Power supply problems

If you suspect a power problem, use the following procedures.

Check/Verify	FRU/Action
Check the following for proper installation. • Power cord • On/Off switch connector • On/Off switch power supply connector • System board power supply connectors • CPU connection	Reseat connectors
Check the power cord for continuity.	Power cord
Check the power-on switch for continuity.	Power-on switch

Beep symptoms

Beep symptoms are tones or a series of tones separated by pauses (intervals without sound) during POST.

The following table describes the beep symptoms.

Beep symptom	FRU/Action
2 short beeps: common POST error	Common POST error code. See the detailed failure information in "POST error codes" on page 34.
3 short and 1 long beeps: DRAM memory error	Perform the following actions in order: 1. Make sure that the memory modules are properly seated in the memory slots. 2. Replace the memory modules. 3. Replace the system board.
4 long beeps: insufficient shadow RAM resources for option ROM (error code: 8998) or PCIe/PCI MMIO (memory mapped input/output) resources (error code: 8999)	See the detailed failure information in "POST error codes" on page 34.
2 long and 3 short beeps: graphics card error	Perform the following actions in order: 1. Make sure that the graphics cards are properly seated in the slots. 2. Replace the graphics cards. 3. Replace the system board.

POST error codes

Each time you turn on the system, it performs a series of tests that check the operation of the system and some options. This series of tests are called the *Power-On Self-Test*, or *POST*. POST checks the following operations:

- Some basic system-board operations
- Memory operation
- Video operation
- Whether the boot drive is working

If the POST detects a problem, an error message appears on the screen. A single problem might cause several error messages to appear. When you correct the cause of the first error message, the other error messages probably will not appear on the screen the next time.

Error code	POST error message	Description/Action
0135	CPU fan failure System fan failure Power fan failure Front fan failure Rear fan failure Auxiliary fan failure ODD fan failure	This error message is displayed when a fan fails and the system might be overheating. Press F10 to exit.
0162	Setup data integrity check failure	This error indicates the checksum of BIOS Setup data in NVRAM is bad. In BIOS Setup, the “Save Changes and Exit” operation is needed in order to clear this error.
0164	Memory configuration change has occurred	This error message is displayed when the memory size is changed. Press F10 to exit.
1762	Storage device configuration change has occurred	This error message is displayed when a hard disk drive change or an optical drive change has been made. Press F10 to exit.

Error code	POST error message	Description/Action
8998	Not enough shadow RAM resources for OPTION ROM, not all devices initialized. Suggest to remove some add-on cards, or change to UEFI mode in BIOS setup.	This error message is displayed when the shadow RAM resources for option ROM are insufficient. If the legacy option ROM is insufficient, remove some add-in cards. For the system that supports UEFI, set UEFI as the first priority.
8999	Not enough PCIe/PCI MMIO resources. Currently only one video card is enabled. Remove some PCIe cards.	This error message is displayed when the PCIe/PCI MMIO (memory mapped input/output) resources are insufficient. Remove some add-in cards.

Miscellaneous error conditions

Message/Symptom	FRU/Action
Changing display colors	Display/Monitor
Computer will <i>not</i> power-off. See “Hard disk drive boot error” on page 32.	1. Power Switch 2. System Board 3. Riser card, if installed.
Computer will <i>not</i> RPL from server	1. Ensure that the network is in startup sequence as the first device or the first device after diskette. 2. Ensure that the network adapter is enabled for RPL. 3. Network adapter (Advise network administrator of new MAC address)
Computer will <i>not</i> perform a Wake On LAN® (if applicable)	1. Check the power supply and signal cable connections to the network adapter. 2. Ensure that the operating system settings are set to enable Wake on LAN. 3. Ensure that the Wake On LAN feature is enabled in Setup/Configuration. 4. Ensure that the network administrator is using the correct MAC address. 5. Ensure no interrupt or I/O address conflicts. 6. Network adapter (advise network administrator of new MAC address)
Dead computer. See “Hard disk drive boot error” on page 32.	1. Power Supply 2. System Board
Diskette drive in-use light remains on or does not light when drive is active.	1. Diskette Drive 2. System Board 3. Diskette Drive Cable

Message/Symptom	FRU/Action
Blank screen except for flashing cursor.	1. System Board 2. Primary Hard Disk Drive 3. Hard Disk Drive Cable
Incorrect memory size during POST	1. Run the Memory tests. 2. Memory Module 3. System Board
"Insert a Diskette" icon appears with a known-good diagnostics diskette in the first 3.5-inch diskette drive.	1. System Board 2. Diskette Drive Cable 3. Network Adapter
Intensity or color varies from left to right of characters and color bars	1. Display 2. Video adapter (if present) 3. System Board
No power or fan not running	1. See "Hard disk drive boot error" on page 32.
Non-system disk or disk error-type message with a known-good diagnostic diskette.	1. Diskette Drive 2. System Board 3. Diskette Drive Cable
Other display symptoms not listed above (including blank or illegible display)	1. Display 2. System Board
Power-on indicator or hard disk drive in-use light not on, but computer works correctly	1. Power switch/LED assembly 2. System Board
Printer problems	1. Printer 2. System Board
Program loads from the hard disk with a known-good diagnostics diskette in the first 3.5-inch diskette drive	1. Run the Setup Utility program and check the Startup sequence. 2. Diskette Drive 3. Diskette Drive Cable 4. System Board 5. Power Supply
RPL computer cannot access programs from its own hard disk.	1. If the network administrator is using LCCM Hybrid RPL, check the startup sequence: a. First device - network b. Second device - hard disk 2. Hard disk drive
RPL computer does not RPL from server	1. Check the startup sequence. 2. Check the network adapter LED status.

Message/Symptom	FRU/Action
Serial or parallel connector device failure (system board connector)	1. External Device Self-Test OK? 2. External Device 3. Cable 4. System Board
Serial or parallel connector device failure (adapter connector)	1. External Device Self-Test OK? 2. External Device 3. Cable 4. Alternate Adapter 5. System Board
Some or all keys on the keyboard do not work	1. Keyboard 2. Keyboard Cable 3. System Board

Undetermined problems

This section provides instructions on how to find out the failing devices or adapters.

1. Turn off the computer.
2. Remove or disconnect the following components (if installed) one at a time.
 - a. External devices (modem, printer, or mouse)
 - b. Any adapters
 - c. Memory modules
 - d. Extended video memory
 - e. External Cache
 - f. External Cache RAM
 - g. Hard disk drive
 - h. Diskette drive
3. Turn on the computer to retest the system.
4. Repeat steps 1 through 3 until you find the failing device or adapter.

If all devices and adapters have been removed, and the problem continues, replace the system board. See Chapter 7 “Hardware removal and installation” on page 45.

Recover from a BIOS update failure

1. Remove all media from the drives and turn off all connected devices.
2. Insert the BIOS update disc into the optical drive, and then turn off the computer.
3. Disconnect all power cords from electrical outlets. Then, remove any parts that impede access to the Clear CMOS jumper.
4. Move the jumper from the standard position to the Clear CMOS position.
5. Reconnect the power cords for the computer and the monitor to electrical outlets.
6. Turn on the computer and the monitor. When the computer beeps, the recovery process begins.
7. After the recovery process is completed, the computer will be turned off automatically.

Note: Depending on the computer model, the recovery process will take two to three minutes.

8. Disconnect all power cords from electrical outlets.
9. Move the jumper back to the standard position.
10. Reinstall all the parts that have been removed. Then, reconnect the power cords for the computer and the monitor to electrical outlets.
11. Turn on the computer and the monitor. When the logo screen is displayed, press F1 or Fn+F1.
12. To prevent data loss, ensure that BIOS settings are restored to an earlier point.

Clear CMOS

1. Remove all media from the drives and turn off all connected devices and the computer.
2. Disconnect all power cords from electrical outlets. Then, remove any parts that impede access to the Clear CMOS jumper.
3. Move the jumper from the standard position to the Clear CMOS position.
4. Reconnect the power cords for the computer and the monitor to electrical outlets.
5. Turn on the computer and the monitor. When the computer beeps, wait for approximately 10 seconds.
6. Turn off the computer by holding the power button for approximately four seconds.
7. Disconnect all power cords from electrical outlets.
8. Move the jumper back to the standard position.
9. Reinstall all the parts that have been removed. Then, reconnect the power cords for the computer and the monitor to electrical outlets.
10. Turn on the computer and the monitor. When the logo screen is displayed, press F1 or Fn+F1.
11. To prevent data loss, ensure that BIOS settings are restored to an earlier point.

Chapter 5. RAID

What is RAID

Redundant Array of Independent Disks (RAID) is a technology that provides increased storage functions and reliability through redundancy. It also can improve data storage reliability and fault tolerance compared with single-drive storage systems. Data loss resulting from a drive failure can be prevented by reconstructing missing data from the remaining drives.

When a group of independent physical storage drives is set up to use RAID technology, they are in a RAID array. This array distributes data across multiple storage drives, but the array appears to the host computer as one single storage unit. Creating and using RAID arrays provides high performance, such as the expedited I/O performance, because several drives can be accessed simultaneously.

RAID Level

Your computer must have the minimum number of solid-state drives installed for the supported level of RAID below:

- RAID 0: striped disk array
 - Consists of at least two solid-state drives
 - Supported strip size: 4 KB, 8 KB, 16 KB, 32 KB, 64 KB, or 128 KB
 - Better performance without fault tolerance
- RAID 1: mirrored disk array
 - Consists of two solid-state drives
 - Improved reading performance and 100% redundancy
- RAID 5: block-level striped disk array with distributed parity
 - Consists of at least three solid-state drives
 - Supported strip size: 16 KB, 32 KB, 64 KB, or 128 KB
 - Better performance and fault tolerance

Configure the system BIOS to enable SATA RAID functionality

To enable SATA RAID functionality:

1. Restart the computer. When the logo screen is displayed, press F1 or Fn+F1.
2. Select **Devices** → **Storage Setup** and press Enter.
3. Select **Configure Storage as** and press Enter.
4. Select **RAID** and press Enter.
5. Press F10 or Fn+F10 to save the changes and exit.

Configure RAID in UEFI mode

This section provides instructions on how to configure RAID in UEFI mode.

Create RAID volumes in UEFI mode

Attention: All the existing data stored on the selected drives will be erased while the RAID volume is being created.

To create RAID volumes:

1. Restart the computer. When the logo screen is displayed, press F1 or Fn+F1.
2. Select **Devices → Storage Setup** and press Enter.
3. Select **Intel (R) Rapid Storage Technology** and press Enter.
4. Select **Create RAID Volume** and press Enter.
5. Select **Name** and press Enter. When prompted, type a proper RAID Volume name in the field.
6. Select **RAID Level** and press Enter. When prompted, select a RAID level in the field.
7. Use the arrow keys and the space key to mark individual physical storage drives to be added in the RAID volume.
8. Select **Strip Size** and press Enter. When prompted, select a strip size in the field.
9. Select **Capacity** and type a volume size in the field.
10. Select **Create Volume** and press Enter to initiate volume creation.

Delete RAID volumes in UEFI mode

Attention: All the existing data stored on the selected drives will be erased after you delete RAID volumes.

To delete RAID volumes:

1. Restart the computer. When the logo screen is displayed, press F1 or Fn+F1.
2. Select **Devices → Storage Setup** and press Enter.
3. Select **Intel (R) Rapid Storage Technology** and press Enter.
4. Select the RAID volume to be deleted and press Enter.
5. Select **Delete** and press Enter.
6. Select **Yes** to confirm the deletion of the selected RAID volume. Deleting a RAID volume will reset the storage drives to non-RAID.

Reset storage drives to non-RAID in UEFI mode

To reset your storage drives to non-RAID:

1. Restart the computer. When the logo screen is displayed, press F1 or Fn+F1.
2. Select **Devices → Storage Setup** and press Enter.
3. Select **Intel (R) Rapid Storage Technology** and press Enter.
4. Select the RAID volumes and press Enter to view the detailed information. Select the storage drives you want to reset to non-RAID and then press Enter.
5. Select **Reset to Non-RAID** and press Enter.
6. Select **Yes** to reset the storage drives to non-RAID.

Chapter 6. Diagnostics

Use diagnostic solutions to test hardware components and report operating-system-controlled settings that interfere with the correct operation of your computer.

Basic procedure for resolving computer problems

Prerequisite

Before you start, read Chapter 1 “Important safety information” on page 1 and print the following instructions.

1. Check that:
 - a. The cables for all connected devices are connected correctly and securely.
 - b. All components have been reassembled correctly.
 - c. All connected devices that require ac power are connected to properly grounded and working electrical outlets.
 - d. All connected devices are enabled in UEFI BIOS.
 2. Use an antivirus program to see if the computer has been infected by a virus. If the program detects a virus, remove the virus.
 3. Go to “Self-help resources” on page 42 and follow the instructions for the type of problem you are experiencing.
 4. Run the diagnostic program.
 5. Recover your operating system. See “Self-help resources” on page 42.
 6. If the problem persists, contact Lenovo.
-

UEFI diagnostic program

A UEFI diagnostic program is preinstalled on the computer. It enables you to test memory modules and internal storage devices, view system information, and check and recover bad sectors on internal storage devices.

To run the UEFI diagnostic program, do the following:

1. Turn on the computer. If the computer cannot be turned on, go to “Basic procedure for resolving computer problems” on page 41. If an error code is displayed, go to “Symptom-to-FRU index” on page 32 for error code descriptions and troubleshooting hints.
2. Repeatedly press and release the F10 key when turning on the computer. The main screen of the UEFI diagnostic program is displayed.
3. Follow the instructions on the screen to use the diagnostic program.

The options on the main screen are as follows:

Table 1. Options on the main screen of the UEFI diagnostic program

DIAGNOSTICS	TOOLS
• CPU [U] • DISPLAY [D] • MEMORY [E] • MOTHERBOARD [H] • PCI EXPRESS [P] • STORAGE [S] • AUDIO [Z] • OPTICAL [O] • RUN ALL [R]	• SYSTEM INFORMATION [F1] • BAD BLOCK RECOVERY [F3] • SMART INFORMATION [F5]

Note: The options on the main screen might vary, depending on the hardware configuration and the UEFI diagnostic program version preinstalled on the computer.

Lenovo diagnostic tools

For information about Lenovo diagnostic tools, go to:
<https://pcsupport.lenovo.com/lenovodiagnosicsolutions>

Self-help resources

Use the following self-help resources to learn more about the computer and troubleshoot problems.

Resources	How to access?
Troubleshooting and frequently asked questions	• https://www.lenovo.com/tips • https://forums.lenovo.com
Accessibility information	https://www.lenovo.com/accessibility
Reset or restore Windows	• Use Lenovo recovery options. 1. Go to https://support.lenovo.com/HowToCreateLenovoRecovery. 2. Follow the on-screen instructions. • Use Windows recovery options. 1. Go to https://pcsupport.lenovo.com. 2. Detect your computer or manually select your computer model. 3. Navigate to the troubleshooting menu to diagnose the operating system for recovery instructions.

Resources	How to access?
Use the Vantage app to: • Configure device settings. • Download and install UEFI BIOS, drivers and firmware updates. • Secure you computer from outside threats. • Diagnose hardware problems. • Check the computer warranty status. • Access <i>User Guide</i> and helpful articles. Note: The available features vary depending on the computer model.	Type Vantage in the Windows search box.
Product documentation: • <i>Safety and Warranty Guide</i> • <i>Generic Safety and Compliance Notices</i> • <i>Setup Guide</i> • <i>This User Guide</i> • <i>Regulatory Notice</i>	Go to https://pcsupport.lenovo.com. Then, follow the on-screen instructions to filter out the documentation you want.
Lenovo Support Web site with the latest support information of the following: • Drivers and software • Diagnostic solutions • Product and service warranty • Product and parts details • Knowledge base and frequently asked questions	https://pcsupport.lenovo.com
Windows help information	• Type Get Help or Tips in the Windows search box. • Use Windows Search. • Microsoft support Web site: https://support.microsoft.com

Chapter 7. Hardware removal and installation

This chapter provides instructions on how to remove and install hardware for your computer.

Handling static-sensitive devices

Do not open the static-protective package containing the new part until the defective part has been removed and you are ready to install the new part. Static electricity, although harmless to you, can seriously damage computer components and options.

When you handle options and other computer components, take these precautions to avoid static-electricity damage:

- Limit your movement. Movement can cause static electricity to build up around you.
- Always handle options and other computer components carefully. Handle PCI/PCIe cards, memory modules, system boards, and CPUs by the edges. Never touch any exposed circuitry.
- Prevent others from touching the options and other computer components.
- Touch the static-protective package containing the part to a metal expansion-slot cover or other unpainted metal surface on the computer for at least two seconds. This reduces static electricity from the package and your body before you install or replace a new part.
- When possible, remove the new part from the static-protective package, and install it directly in the computer without setting the part down. When this is not possible, place the static-protective package on a smooth, level surface and place the part on the package.
- Do not place the part on the computer cover or other metal surface.

Service tool kit

Ensure that the following common service tool kit is prepared before you service the computer.

No.	Tool name	Specification	Product scope	Tool type
1	Screwdriver: Phillips Head 0	PH0	All	Common tool
2	Screwdriver: Phillips Head 00	PH00	All	Common tool
3	Screwdriver: Phillips Head 01	1	All	Common tool
4	Screwdriver: Phillips Head 01	1, Shank length greater than 6 inches	ThinkStation/DT	Common tool
5	Screwdriver: Phillips Head 02	2, Shank length greater than 6 inches	ThinkStation/SC/DT	Common tool
6	Screwdriver: Torx Head T5	T5	IdeaPad	Common tool

No.	Tool name	Specification	Product scope	Tool type
7	Screwdriver: Torx Head T15	T15, for Chassis outside	ThinkStation	Common tool
8	Screwdriver: Torx Head T20	T20, Shank length greater than 6 inches, for heatsink and CPU	ThinkStation	Common tool
9	Screwdriver: Torx Head T30	T30, Shank length greater than 6 inches, for heatsink and CPU	ThinkStation	Common tool
10	Pry tools 1	N/A	All	Common tool
11	Tweezers (conductive)	N/A	All	Common tool
12	Tweezers (isolated)	N/A	All	Common tool
13	Suction cup	N/A	All	Common tool
14	Hexagonal socket (for VGA)	H5 mm or 4.8 mm	ThinkCentre/Tiny	Common tool
15	Hexagonal socket (for Tiny antenna)	H8 mm	ThinkCentre/Tiny	Common tool
16	Adjustable Torque Screwdriver	0.2 Nm to 4.0 Nm, Threadripper CPU, CAMM, etc	All	Common tool
17	ESD Mat	ESD Mat	All	Common tool
18	USB Flash Drives	For Golden Key, Chrome Reloads, AutoPilot, etc	All	Common tool
19	USB-C to USB-A Converter	For USB-C only systems	All	Common tool
20	SSD/WWAN/IC Thermal pad	Thermal pads are typically used under the SSD/WWAN/IC in different thicknesses, the most common being 0.5 mm.	All	Consumable
21	Silicone grease for CPU or heatsink repairing	N/A	All	Consumable
22	Polyamide tape	N/A	All	Consumable

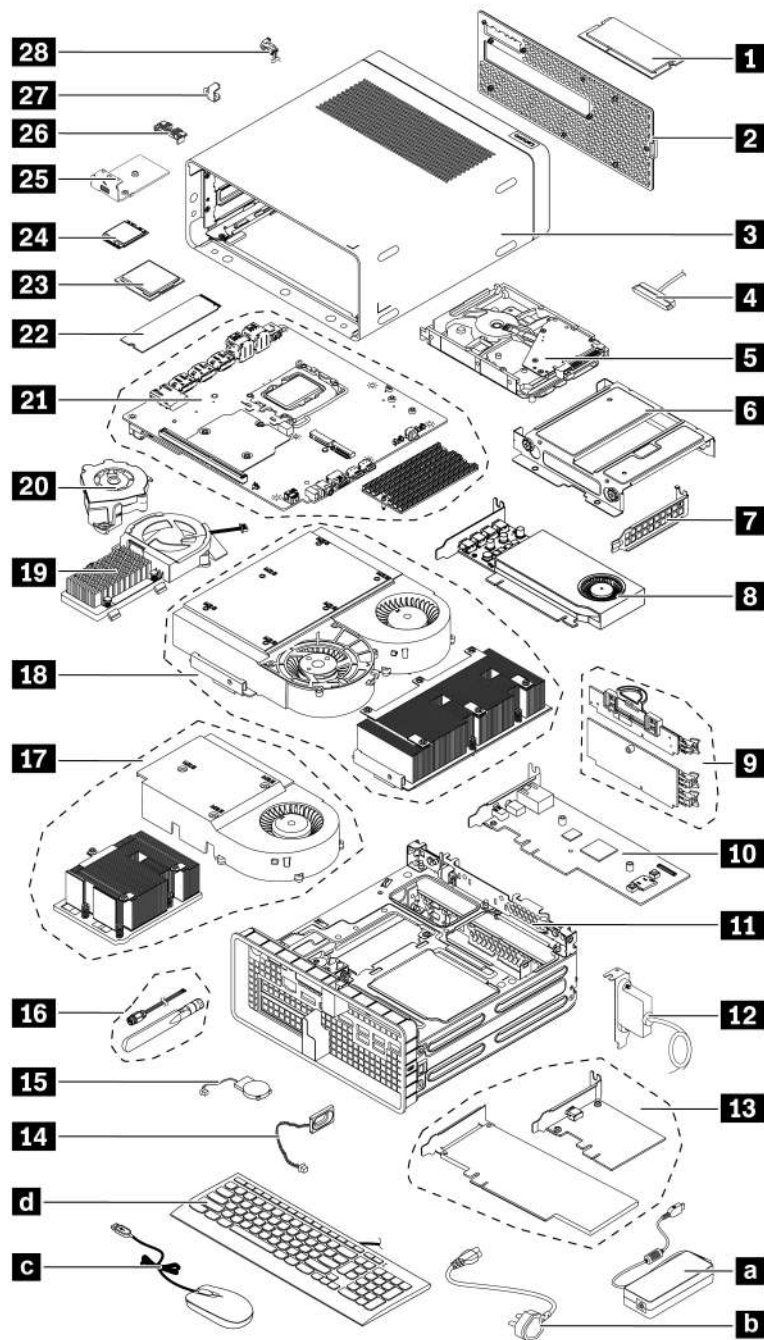
No.	Tool name	Specification	Product scope	Tool type
23	Mylar tape	N/A	All	Consumable
24	Eraser	N/A	All	Consumable
25	Electrical tape	N/A	All	Consumable
26	Double sided tape	N/A	All	Consumable
27	Conductive tape	N/A	All	Consumable
28	Cleaning pads/wipes	N/A	All	Consumable
29	Heat gun	N/A	All	Special Tool (Depot only)
30	Brown brush	25 mm to 35 mm wide	All	Special tool
31	Contact Cleaner Spray	WD-40 Contact Cleaner for battery connector	ThinkPad X1 Carbon	Special tool
32	Hexagonal socket	17 mm	Yoga AIO 7 27ACH6/ Yoga AIO 7 27ARH6	Special tool

Note: The silicone grease can be applied to the surfaces of the CPU and heat sink to eliminate air gaps. For parts with silicone grease applied, it is suggested that you apply new grease during the installation.

Major FRUs and CRUs

Your computer contains the following types of CRUs and FRUs:

- **Self-service CRUs:** Refer to parts that can be replaced easily by customer themselves or by trained service technicians at an additional cost.
- **Optional-service CRUs:** Refer to parts that can be replaced by customers with a greater skill level. Trained service technicians can also provide service to replace the parts under the type of warranty designated for the customer's machine.
- **FRUs:** Refer to parts that are more complicated to replace and it is recommended that these should be replaced by trained service technicians. If customers elect to replace the FRUs by themselves, we recommend that you ensure the correct instructions provided by Lenovo are carefully followed.



Number	Description	Self-service CRU	Optional-service CRU
1	Memory module	No	Yes
2	Dust filter*	Yes	No
3	Chassis	Yes	No
4	Hard disk drive cable*	No	Yes
5	3.5-inch hard disk drive*	No	Yes
6	3.5-inch hard disk drive bracket kit*	No	Yes
7	PCI-Express card bracket	Yes	No

Number	Description	Self-service CRU	Optional-service CRU
8	Graphics card*	No	Yes
9	Single-slot and dual-slot PCI-Express card converter*	No	Yes
10	BMC card*	No	No
11	System board tray	No	No
12	COM cable kit*	No	Yes
13	PCI-Express card*	No	Yes
14	Internal speaker	No	No
15	CMOS battery	No	No
16	Wi-Fi antenna and Wi-Fi antenna cable*	No	No
17	65-watt system fan and heat sink*	No	No
18	125-watt system fan and heat sink*	No	No
19	M.2 solid-state drive thermal kit*	No	Yes
20	Hard disk drive fan*	No	Yes
21	System board tray and solid-state drive heatsink	No	No
22	M.2 solid-state drive*	Yes	No
23	Microprocessor	No	No
24	Wi-Fi card*	No	No
25	Board to board Thunderbolt 4 card	No	No
26	Wi-Fi card shield*	No	No
27	LED cable holder	No	Yes
28	LED cable	No	Yes
a	ac power adapter	Yes	No
b	Power cord	Yes	No
c	Mouse*	Yes	No
d	Keyboard*	Yes	No

*For selected models

For detailed FRU and CRU information, such as the FRU part numbers and supported computer models, go to: <http://www.lenovo.com/serviceparts-lookup>

System board illustration

Note: The system board might look slightly different from the illustration.

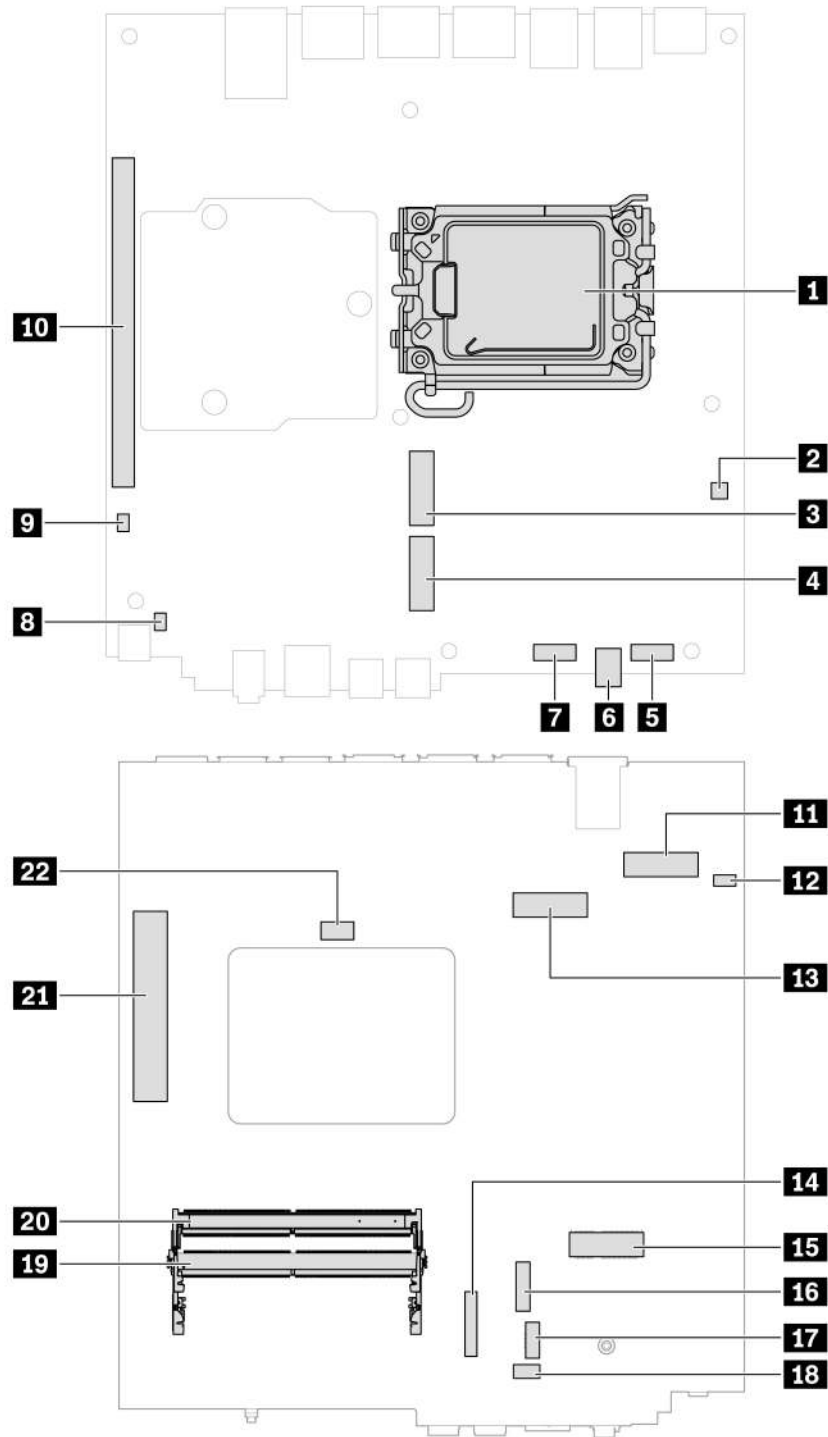
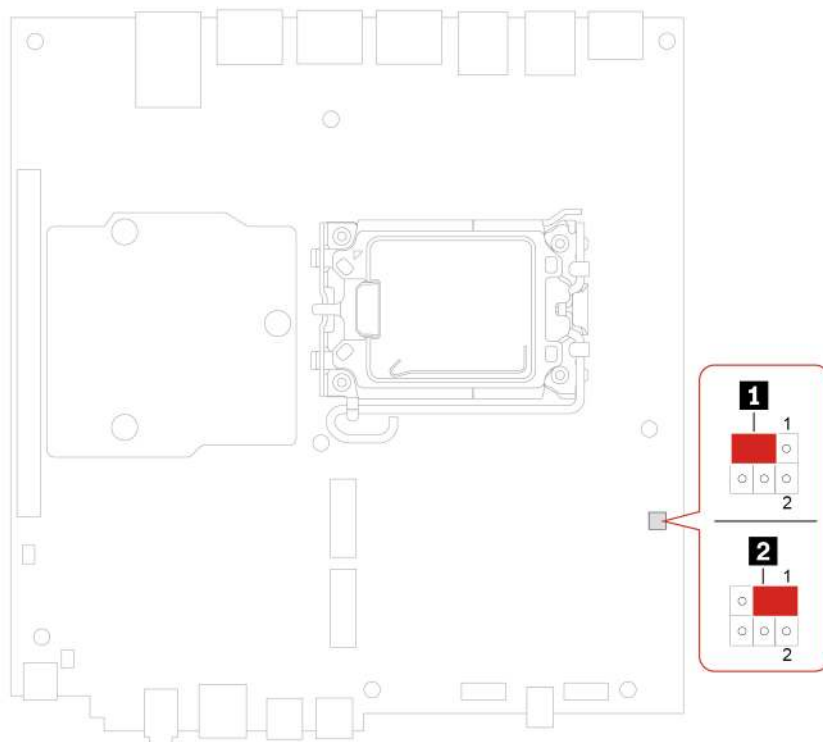


Figure 1. System board part locations

Item	Item
1 Microprocessor	2 Clear CMOS/Recovery jumper
3 Gen 4 M.2 solid-state drive slot 2	4 Gen 5 M.2 solid-state drive slot 1

Item	Item
5 System fan connector 1	6 Cover presence switch
7 System fan connector 2	8 Internal speaker connector
9 Power button connector	10 PCI-Express x16 card slot
11 Thunderbolt 4 board to board connector	12 Coin-cell battery connector
13 Gen 4 M.2 solid-state drive slot 3	14 BMC connector
15 M.2 Wi-Fi card slot	16 SATA connector
17 Auxiliary fan connector	18 ThinkStation LED connector
19 DIMM slot 1	20 DIMM slot 2
21 PCI-Express x4 slot (physical link width x8; negotiable link width x4)	22 COM port connector

Clear CMOS position



Item	Description	Item	Description
1	Standard position	2	Clear CMOS position

Prerequisites for hardware replacement

General prerequisites

Read *Generic Safety and Compliance Notices*.

Prerequisites for opening computer chassis



During operation, some components become hot enough to burn the skin. Before you open the computer cover, do the following :

- Turn off the computer and remove all connected devices and cables.
- Disconnect the computer from ac power and all connected cables.
- Unlock any locking device that secures the chassis.
- Wait approximately 10 minutes until the computer is cool.

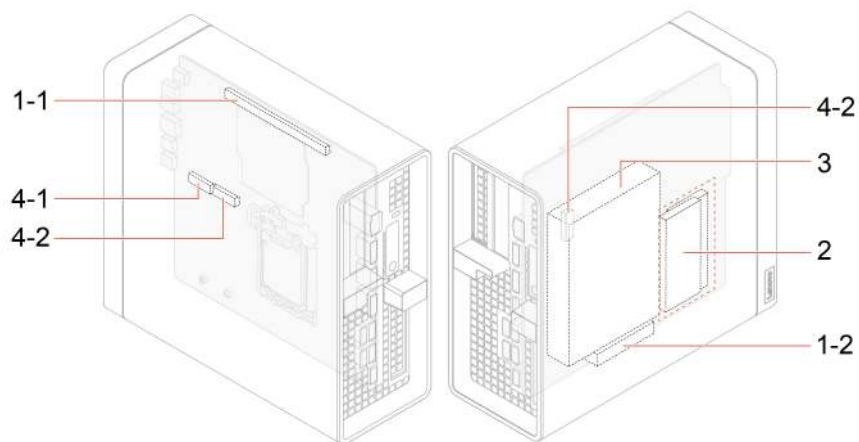
Prerequisites for storage drive replacement

Attention: The internal storage drive is sensitive. Inappropriate handling might cause damage and loss of data. When handling the internal storage drive, observe the following guidelines:

- Replace the internal storage drive only for repair. The internal storage drive is not designed for frequent changes or replacement.
- Before replacing the internal storage drive, make backup copy of all the data that you want to keep.
- Do not touch the contact edge of the internal storage drive. Otherwise, the internal storage drive might get damaged.
- Do not apply pressure to the internal storage drive.
- Do not make the internal storage drive subject to physical shocks or vibration. Put the internal storage drive on soft material, such as a cloth, to absorb physical shocks.

Expand your computer

You can enhance your computer capacity and performance by adding various devices according to the following rules:



Item	Description	Expansion
1-1	Gen 4 PCI-Express x16 slot	You can install the following compatible PCI-Express cards in the PCI-Express cards slots: • DisplayPort graphics card (2-port) • Mini-DisplayPort graphics card (4-port) • USB-C connector (USB 20Gbps) expansion card (1-port) • USB-C connector (USB 5Gbps) expansion card (2-port) • USB-C connector (USB 10Gbps) expansion card (2-port) • Ethernet expansion card (2-port or 4-port) • Serial expansion card (4-port) • Baseboard Management Controller (BMC) card
1-2	Gen 3 PCI-Express x4 slot (physical link width x8; negotiable link width x4)	
2	Memory slots	You can install up to two memory cards in the memory slots.
3	Storage drive bay*	You can install one 3.5-inch hard disk drive in the storage drive bay.
4-1	Gen 5 M.2 solid-state drive slot	You can install one Gen 5 M.2 solid-state drive in the M.2 solid-state drive slots.
4-2	Gen 4 M.2 solid-state drive slots	You can install up to two Gen 4 M.2 solid-state drives in the M.2 solid-state drive slots.

* for selected models

Removing and installing hardware

This section provides instructions on how to remove and install hardware for your computer.

Attention: Do not open your computer or attempt any repair before reading and understanding the Chapter 1 “Important safety information” on page 1.

External options

You can connect external options to your computer, such as external speakers, a printer, or a scanner. For some external options, you must install additional software in addition to making the physical connection. When installing an external option, see Chapter 3 “Product overview” on page 29 to identify the required connector. Then, use the instructions that come with the option to help you make the connection and install any required software or device drivers.

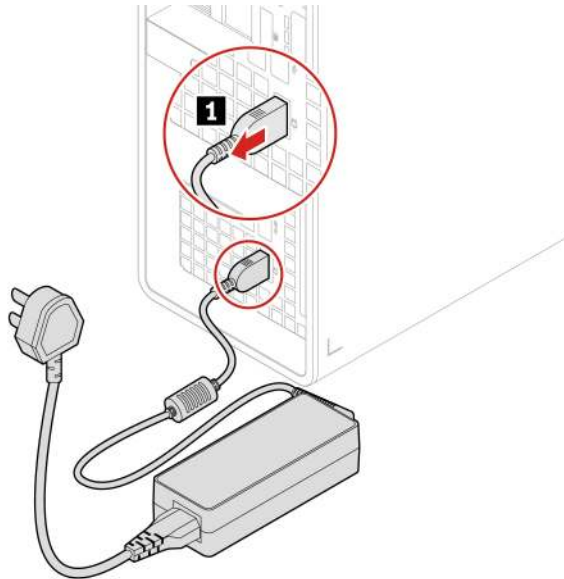
Power adapter and power cord

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

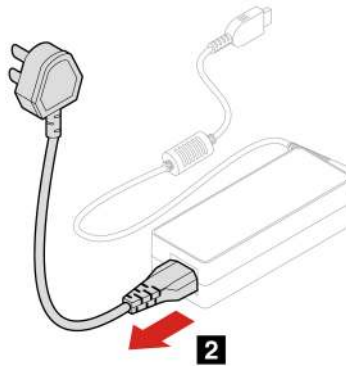
For access, turn off the computer and remove all connected devices and cables.

Removal steps

1. Remove the power adapter.



2. Remove the power cord.

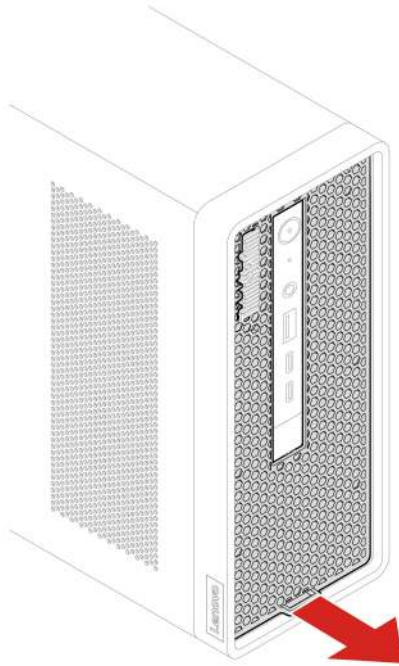


Dust filter

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

Removal steps

Pull the dust filter to remove it from the chassis.

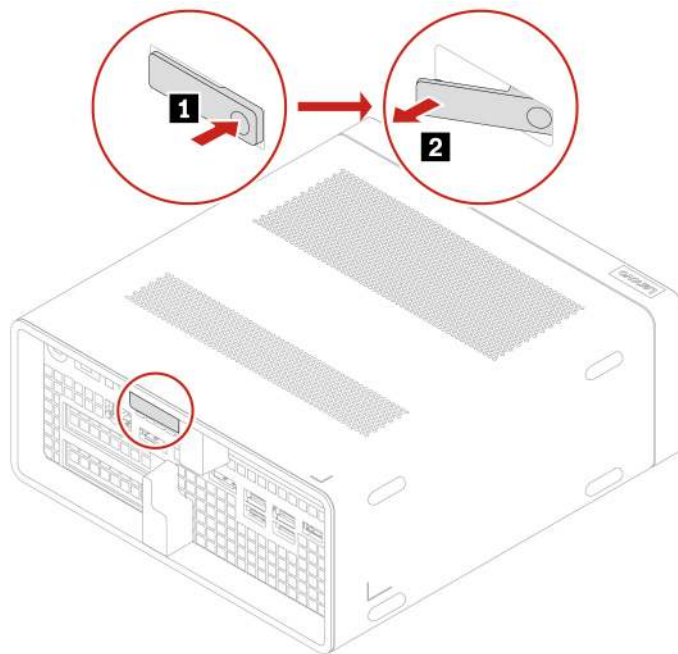


Chassis

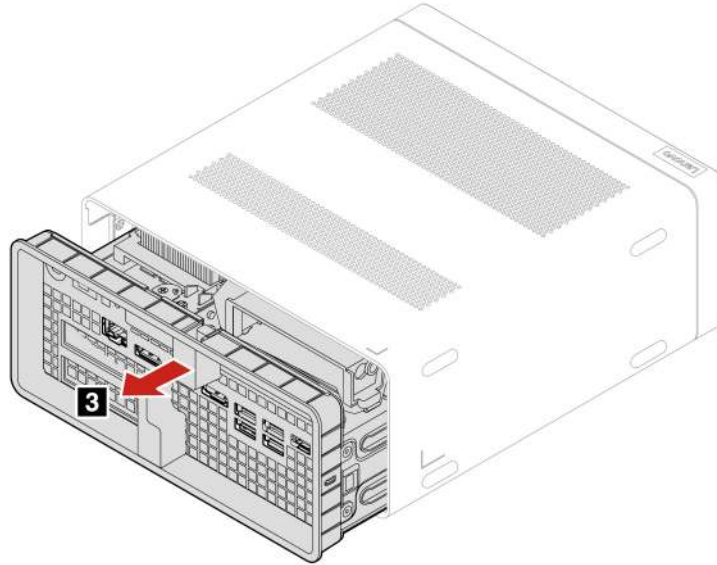
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

Removal steps

1. Push and open the chassis latch.



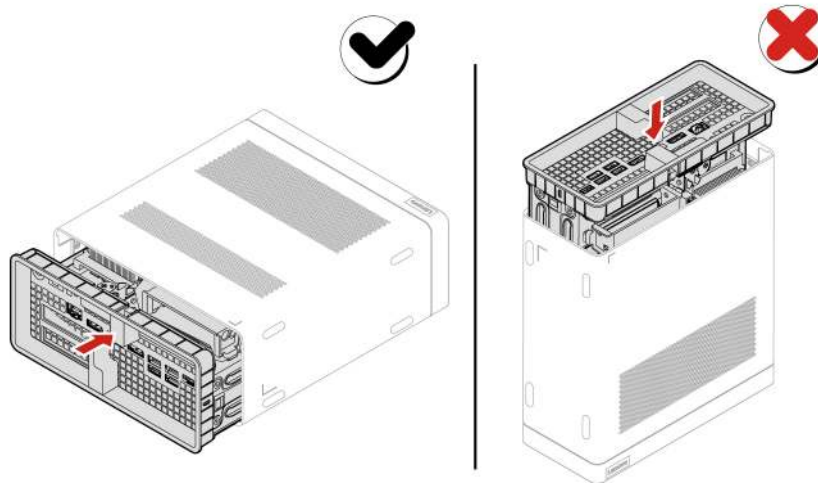
2. Pull the latch to remove the chassis.



Installation steps

Install the chassis.

Note: Push the parts into place until you hear a clicking sound.



M.2 solid-state drive thermal kit

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

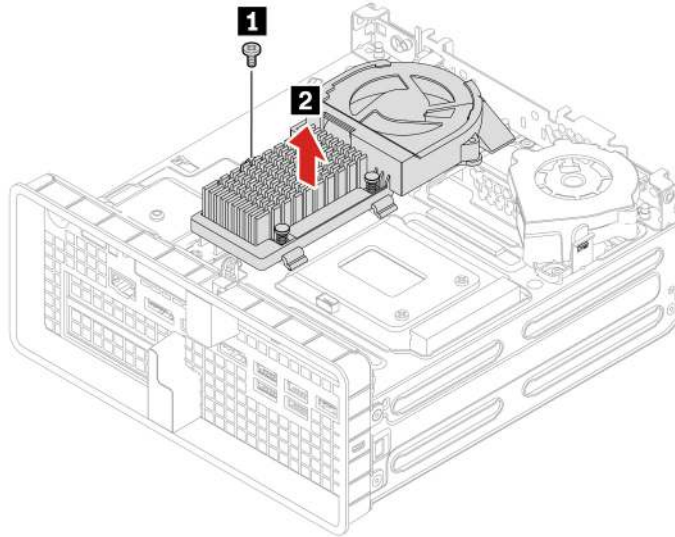
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the 3.5-inch hard disk drive bracket kit. See “3.5-inch hard disk drive bracket kit” on page 63
4. Disconnect the power cable from the thermal kit.

Removal steps

1. Remove the screw which secures the M.2 solid-state drive thermal kit to the chassis. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L5, hex screw	1	3 ± 0.5 lb/in

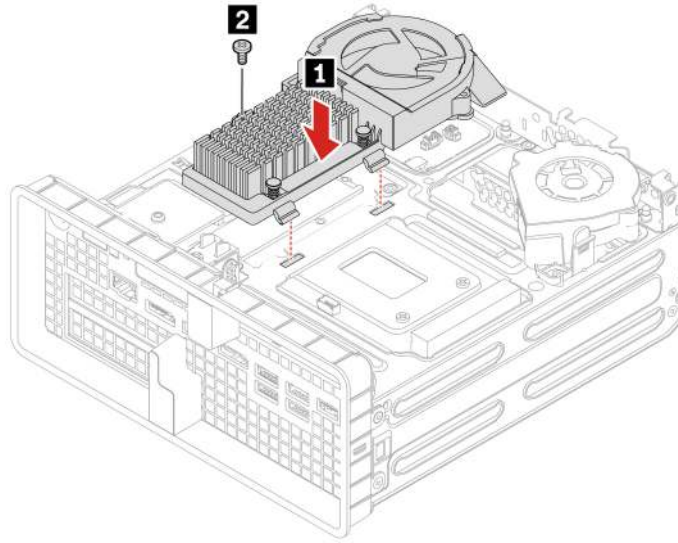
2. Remove the M.2 solid-state drive thermal kit.



Installation steps

1. Align the two hooks on the M.2 solid-state drive thermal kit with the holes on the chassis.
2. Secure the M.2 solid-state drive thermal kit with a screw. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L5, hex screw	1	3 ± 0.5 lb/in



Attention: Use the screws provided by Lenovo to avoid any unpredictable damage to your computer.

M.2 solid-state drive

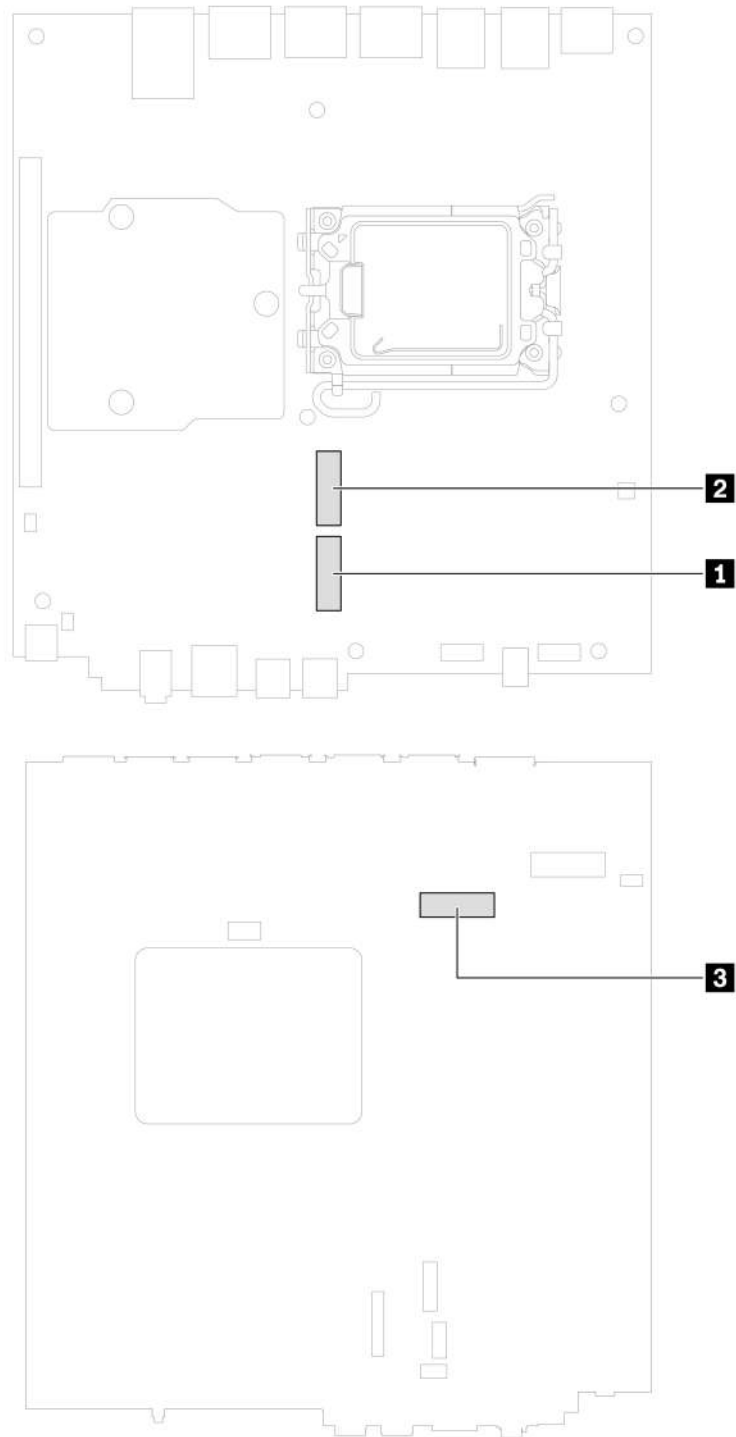
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the 3.5-inch hard disk drive bracket kit. See “3.5-inch hard disk drive bracket kit” on page 63.
4. Remove the M.2 solid-state drive thermal kit. See “M.2 solid-state drive thermal kit” on page 56.

Notes:

- Ensure that you follow the installation order for M.2 solid-state drives shown in the following illustration.
- Install Gen 5 M.2 solid-state drive only in slot 1.

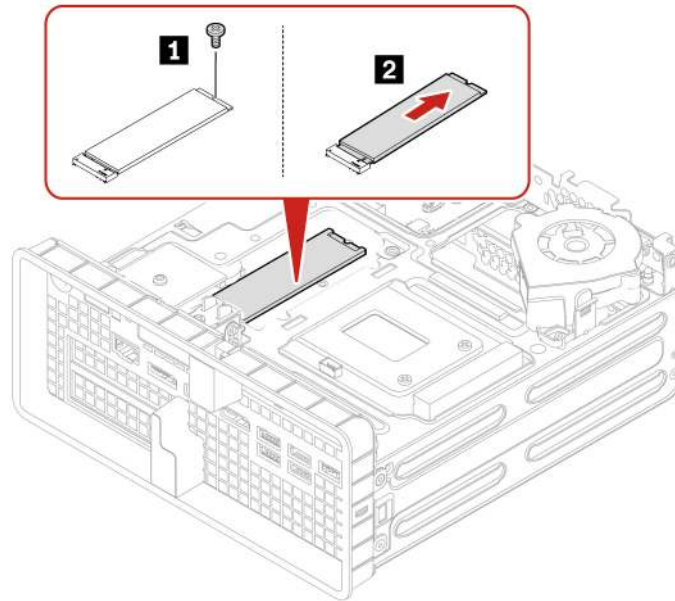


Removal steps for M.2 solid-state drive in slot 3

1. Remove the screw which secures the M.2 solid-state drive to the system board. Find screw specification in the following screw table.

Screw	Quantity	Torque
M2 x L3, flat head	1	1.5 ± 0.2 lb/in

2. Remove the M.2 solid-state drive.

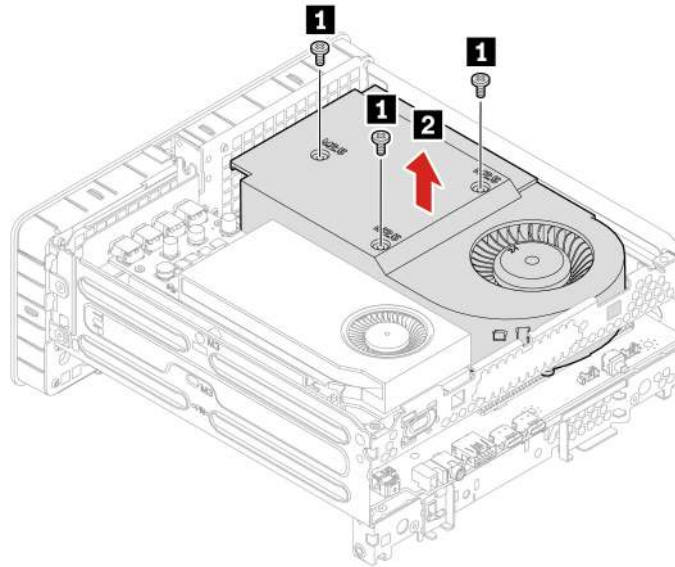


Removal steps for M.2 solid-state drive in slot 1 and slot 2

1. Remove the system fan.
 - Remove the 65-watt system fan.
 - a. Remove the three screws which secure the 65-watt system fan. Find screw specification in the following screw table.

Screw	Quantity	Torque
M2.5 x L4.5, flat head	3	1.5 ± 0.2 lb/in

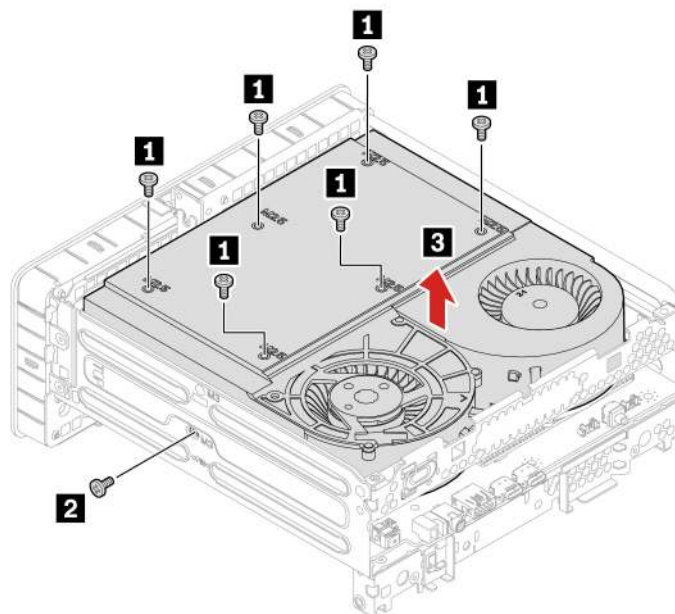
- b. Lift the system fan.



- Remove the 125-watt system fan.
 - a. Remove the seven screws which secure the 125-watt system fan. Find screw specification in the following screw table.

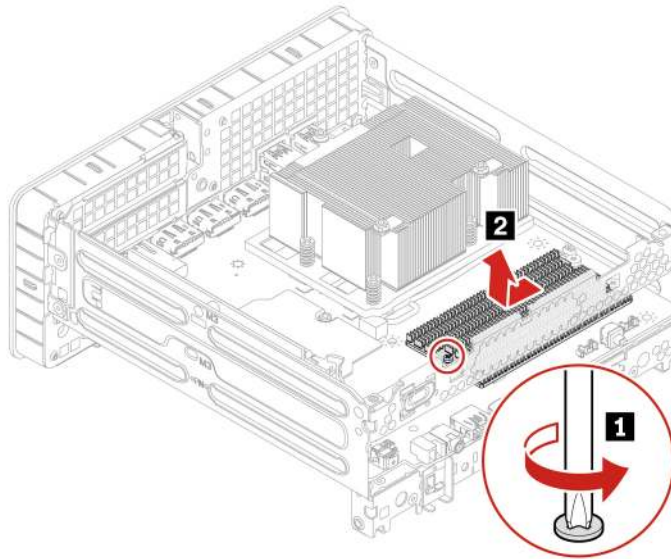
Screw	Quantity	Torque
M2.5 x L4.5, flat head	6	1.5 ± 0.2 lb/in
M3 x L5, countersunk	1	5.0 ± 0.5 lb/in

- b. Lift the system fan.



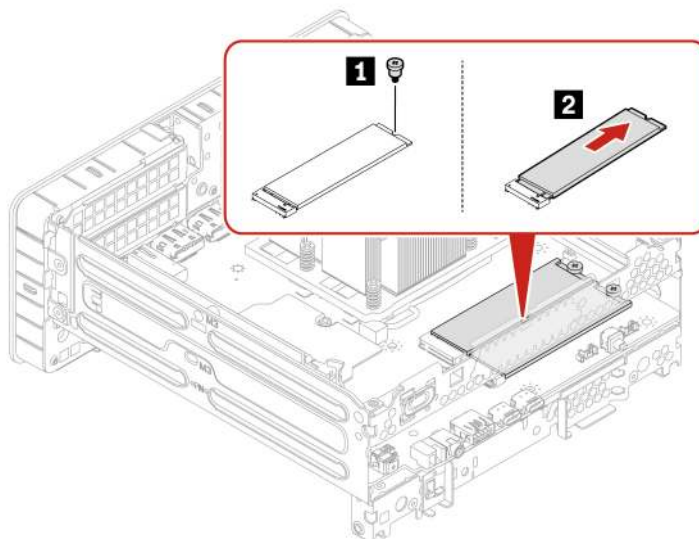
2. Remove the M.2 solid-state drive heatsink. Find screw specification in the following screw table.

Screw	Quantity	Torque
M2 x L3, flat head	1	1.5 ± 0.2 lb/in



3. Remove the M.2 solid-state drive. Find screw specification in the following screw table.

Screw	Quantity	Torque
M2 x L3, flat head	1	1.5 ± 0.2 lb/in



Hard disk drive fan

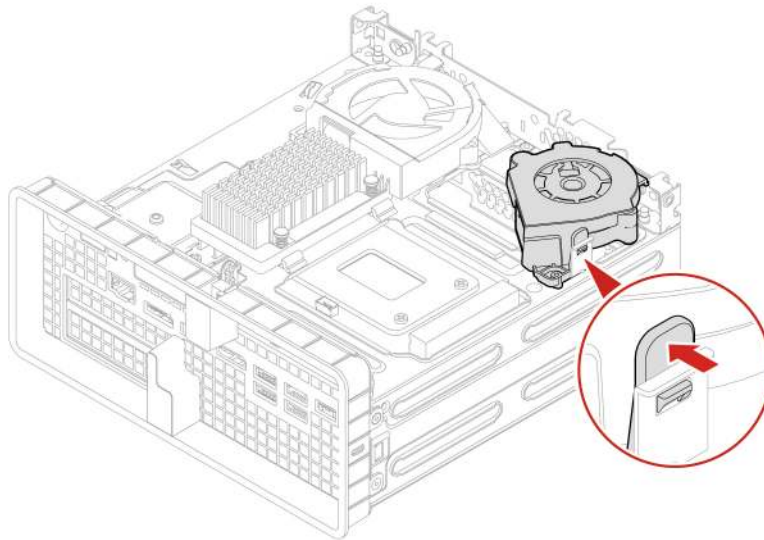
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Disconnect the cable from the hard disk drive fan.

Removal steps

Press the tab to release the hard disk drive fan from the chassis.



3.5-inch hard disk drive bracket kit

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

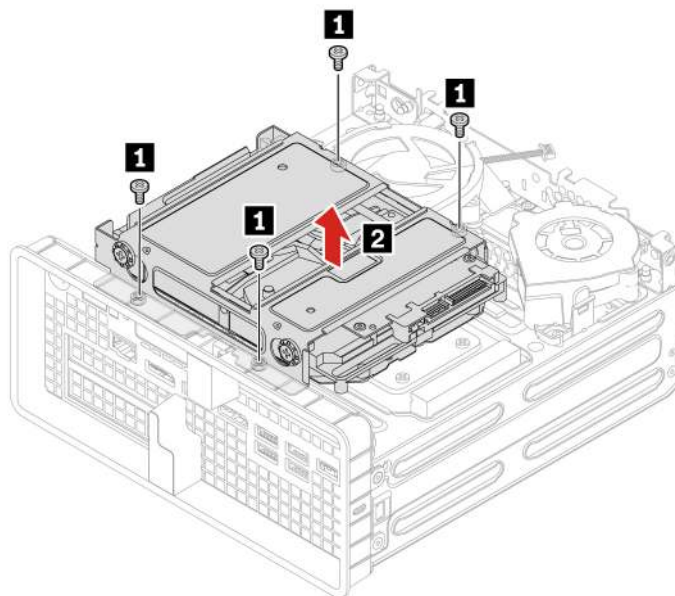
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Disconnect the signal cable and the power cable from the storage drive.

Removal steps

1. Remove the four screws which secure the 3.5-inch hard disk drive bracket kit to the chassis. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L5, hex screw	4	5 ± 0.5 lb/in

2. Lift the 3.5-inch hard disk drive bracket kit.



3.5-inch hard disk drive

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

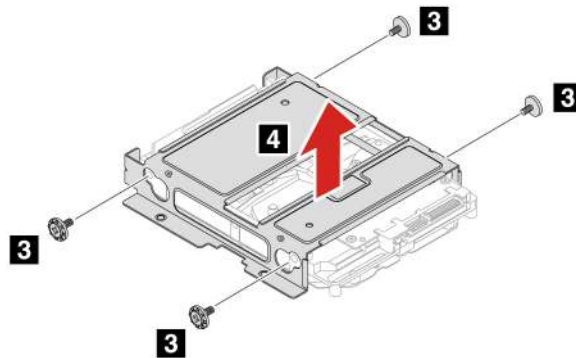
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the 3.5-inch hard disk drive bracket kit. See “3.5-inch hard disk drive bracket kit” on page 63.
4. Disconnect the signal cable and the power cable from the storage drive.

Removal steps

1. Remove the four screws which secure the 3.5-inch hard disk drive to the bracket kit. Find screw specification in the following screw table.

Screw	Quantity	Torque
#6-32 x L11, flat head	4	5 ± 0.5 lb/in

2. Remove the 3.5-inch hard disk drive from the bracket kit.



LED cable and holder

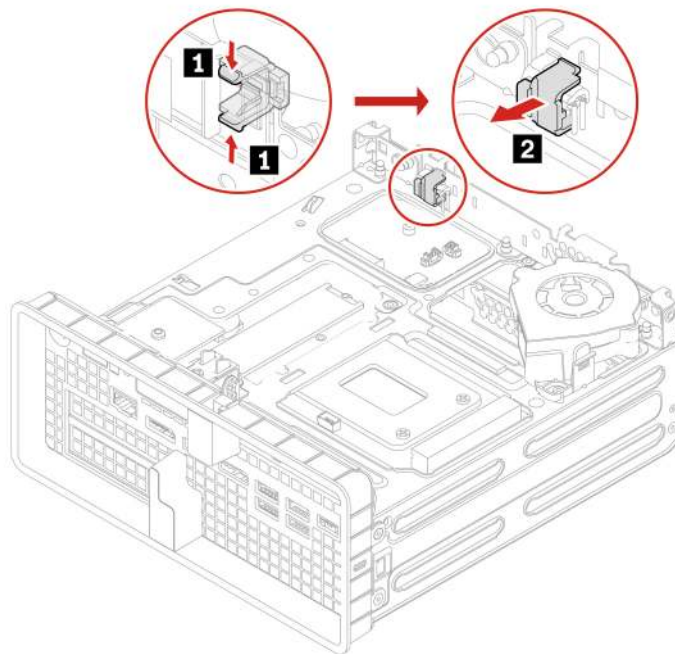
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.

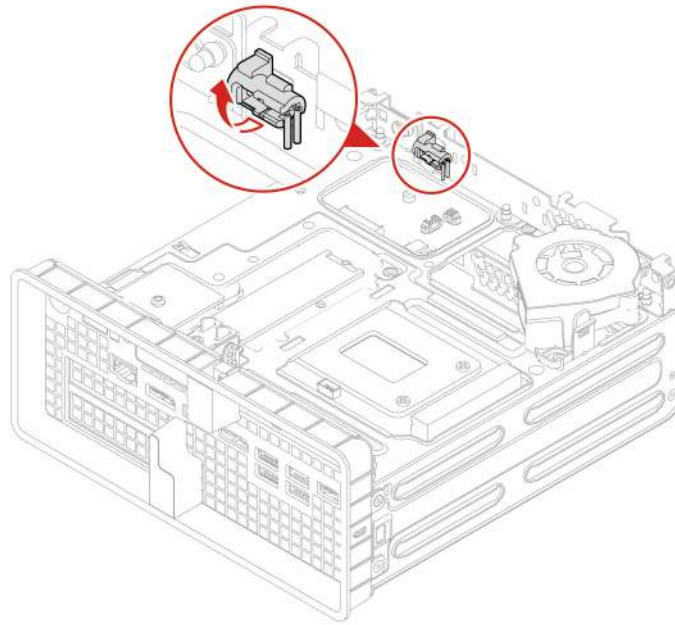
Removal steps for LED holder

Pinch the two tabs of the LED holder and pull to remove it from the chassis.



Removal steps for LED cable

Twirl to remove the LED cable.

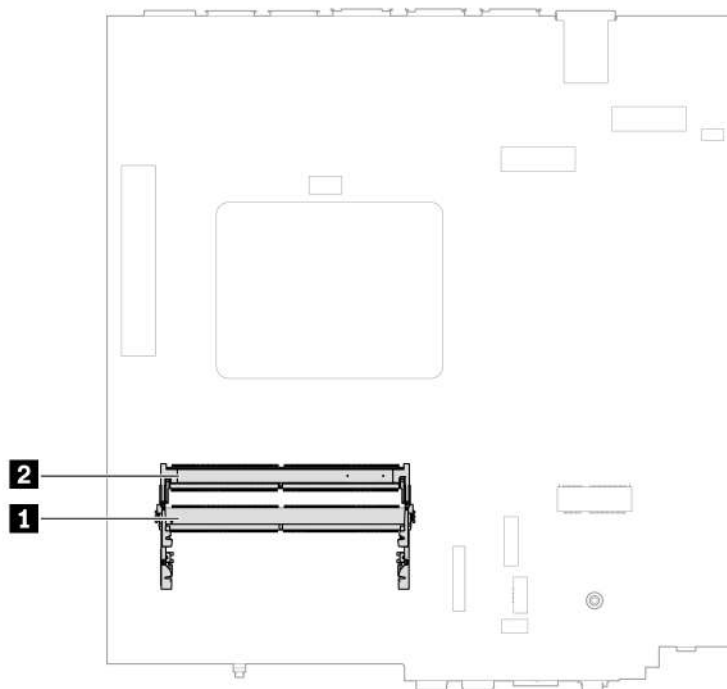


Memory module

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

Notes:

- To remove or install the memory module, wait at least 20 seconds after disconnecting power cords from the system. It allows the system to be completely discharged of electricity.
- Ensure that you follow the installation order for memory modules shown in the following illustration.

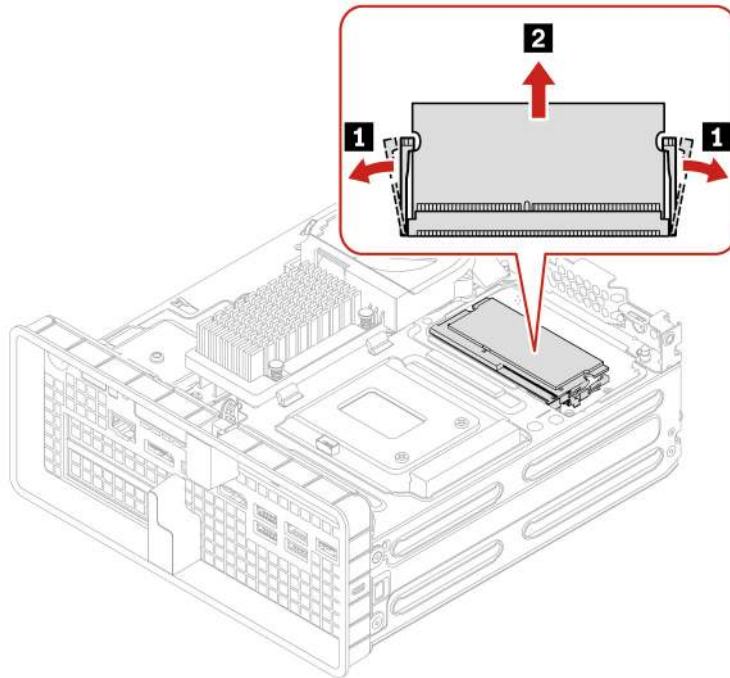


For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the hard disk drive fan. See “Hard disk drive fan” on page 62.

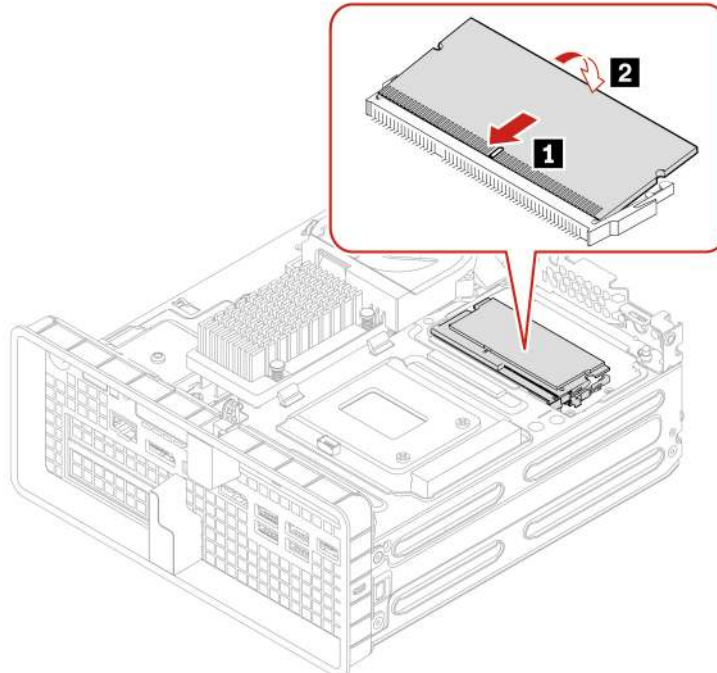
Removal steps

1. Open the two retaining tabs.
2. Lift the memory module out of the slot.



Installation steps

Align the memory module to the slot and push until the latches are fully engaged with a click.



PCI-Express bracket

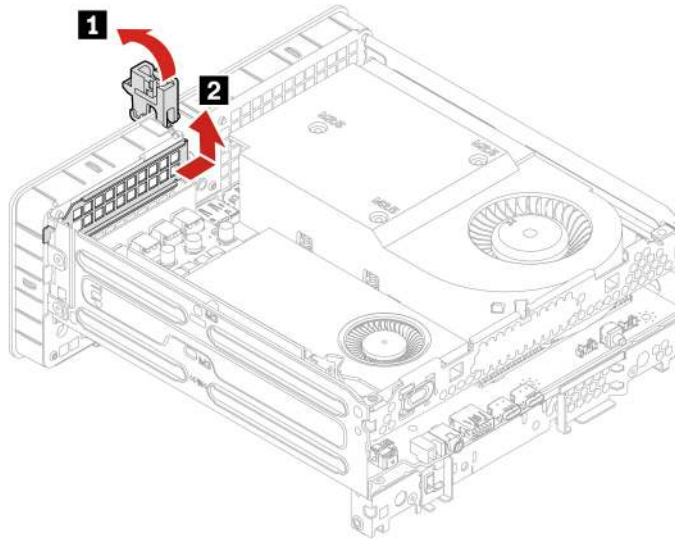
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.

Removal steps

Open the latch and remove the PCI-Express bracket.



PCI-Express card (including graphics card)

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the PCI-Express bracket. See “PCI-Express bracket” on page 68.

Note: Before installing a new PCI-Express card, remove any PCI-Express connector cables that impede the installation.

PCI-Express card installation rule

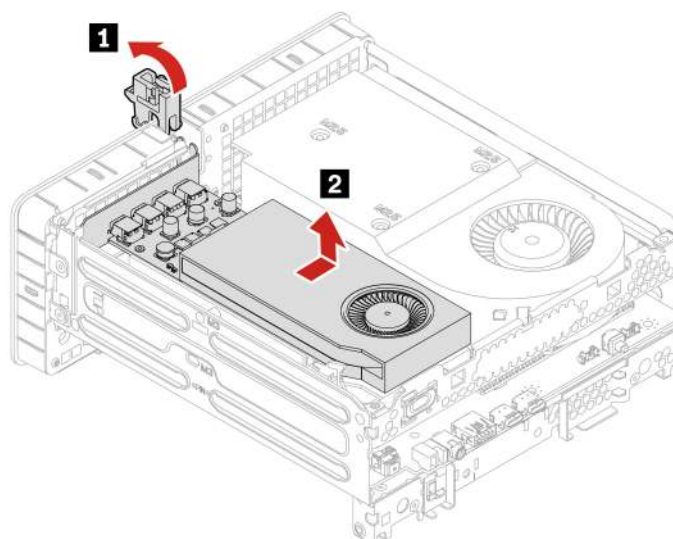
- For graphics cards installation, the PCI-Express x16 slot is the primary slot, and the PCI-Express x4 slot is the secondary slot.
- For other PCI-Express cards installation, the PCI-Express x4 slot is the primary slot, and the PCI-Express x16 slot is the secondary slot.
- Before installing a new PCI-Express card, ensure your power supply has adequate capacity and verify the microprocessor’s power requirements to maintain system stability. You can refer to the table below for detailed power requirement.

Power supply	Microprocessor	PCI-Express card
230 watt	35 watt	You can install a graphics card and a PCI-Express card with power consumption below 30 watt. Note: You are recommended to install one graphics card only.
230 watt	65 watt	You can install a graphics card with power consumption below 50 watt only.
330 watt	35 watt / 65 watt	330-watt power supply can support higher-consumption PCI-Express cards and graphics cards.

- To install a dual-slot graphics card, such as RTX 2000E Ada or RTX 4000 SFF Ada, a single-slot PCI-Express card converter is required.

Removal steps

Open the latch and pull to remove the PCI-Express card.



PCI-Express card converter

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

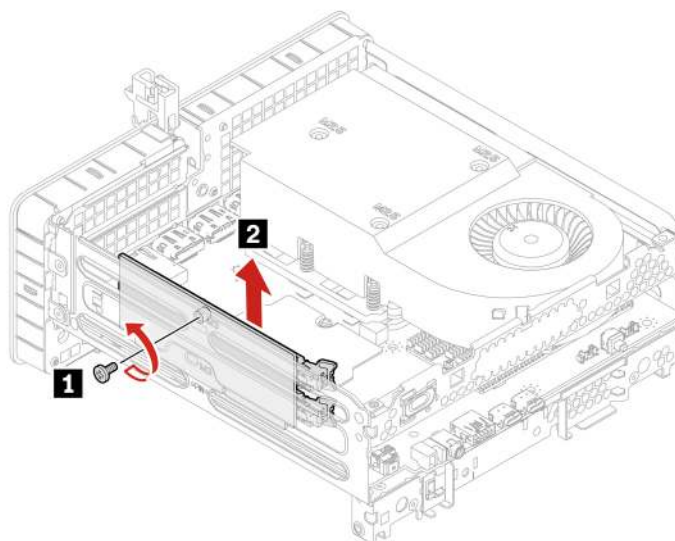
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the PCIe bracket. See “PCI-Express bracket” on page 68.
4. Remove the PCIe card. See “PCI-Express card (including graphics card)” on page 69

Removal steps for dual-slot PCI-Express card converter

1. Remove the screw that secure the converter to the chassis. Find screw specification in the following screw table.

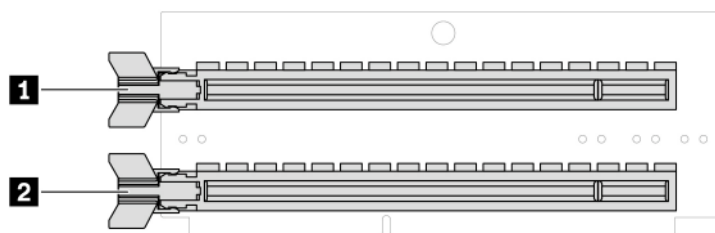
Screw	Quantity	Torque
M3 x L5, countersunk	1	3 ± 0.5 lb/in

2. Pull the PCI-Express card converter out of the PCI-Express slot.



Notes: Ensure that you follow the installation order for dual-slot PCI-Express card converter:

- For graphics cards installation, slot 1 is the primary slot.
- For other PCI-Express cards installation, slot 2 is the primary slot and slot 1 is the secondary slot.

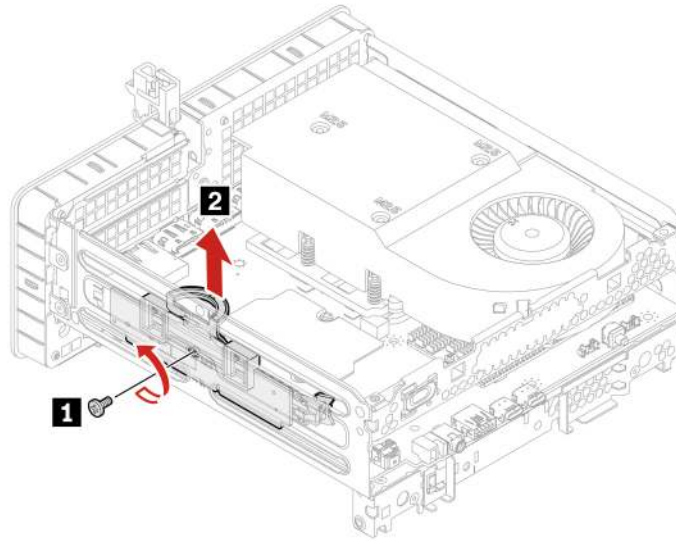


Removal steps for single-slot PCI-Express card converter

1. Remove the screw that secure the converter to the chassis. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L5, countersunk	1	3 ± 0.5 lb/in

2. Pull the PCI-Express card converter out of the PCI-Express slot.



BMC card

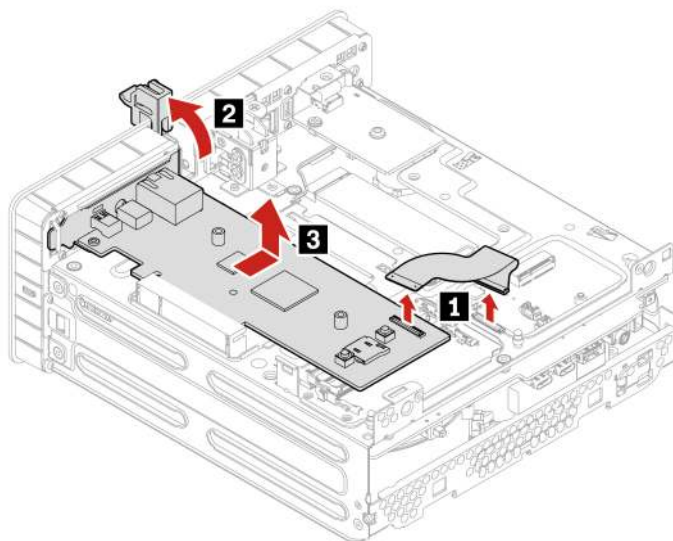
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the M.2 solid-state drive thermal kit. See “M.2 solid-state drive thermal kit” on page 56.

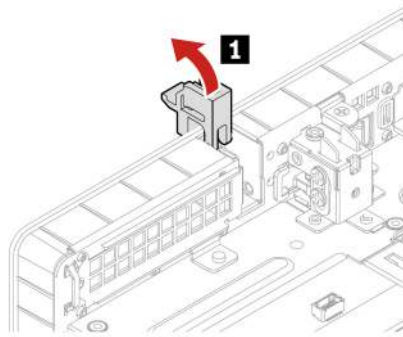
Removal steps

1. Disconnect the cable from the BMC card.
2. Open the PCI-Express latch and remove the BMC card.

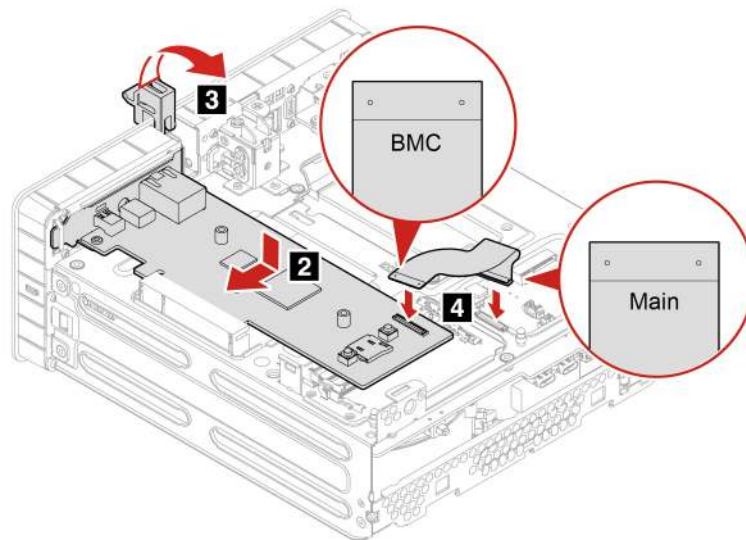


Installation steps

1. Open the PCI-Express latch.



2. Install the BMC card and close the latch.
3. Connect the cable to the BMC card and the system board.



Board to board Thunderbolt 4 card

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

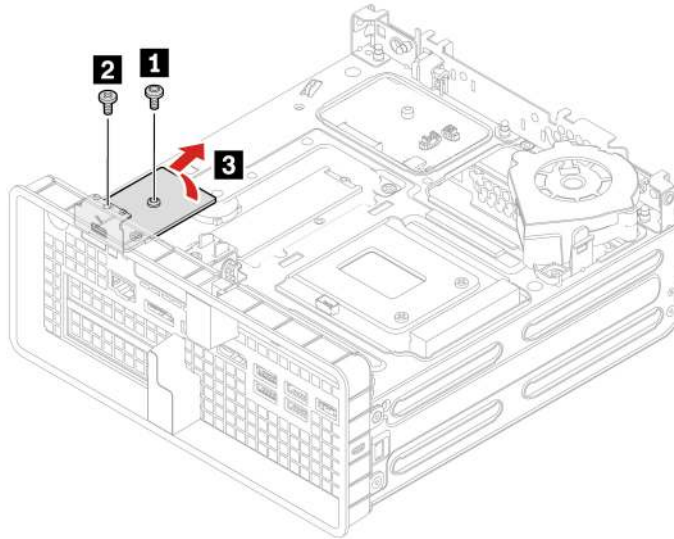
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the 3.5-inch hard disk drive bracket kit. See “3.5-inch hard disk drive bracket kit” on page 63.

Removal steps

1. Remove the two screws which secure the Thunderbolt 4 card to the system board and the chassis. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L12, round head	1	3 ± 0.5 lb/in
M3 x L4, countersunk	1	3 ± 0.5 lb/in

2. Remove the Thunderbolt 4 card.



Internal speaker

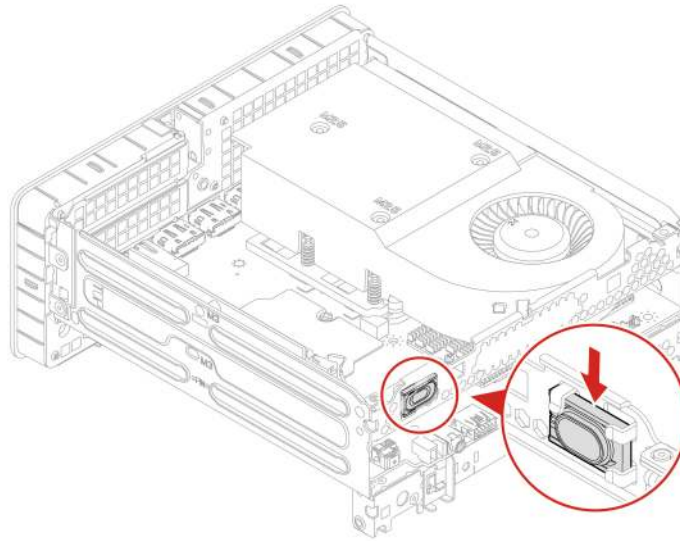
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

1. Remove these parts in order, if any:
 - “Power adapter and power cord” on page 53
 - “Chassis” on page 55
2. Disconnect the internal speaker cable from the system board.

Removal steps

Push the internal speaker downwards to remove it from the chassis.



Wi-Fi card and Wi-Fi card shield

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, remove the following parts in order:

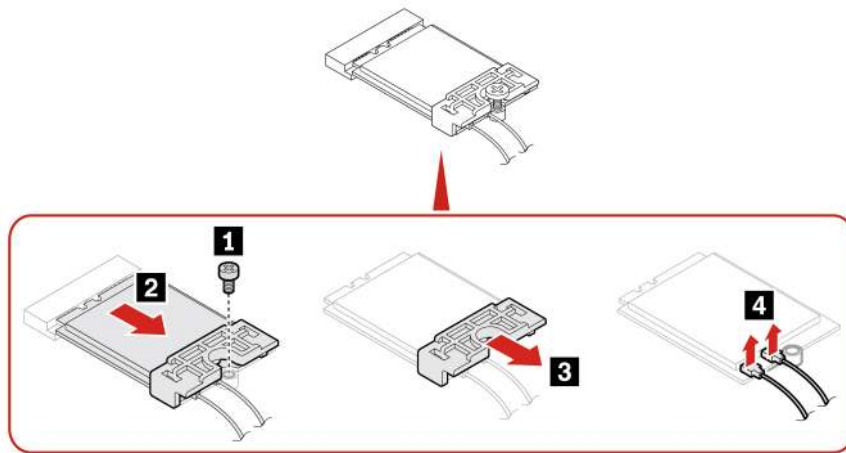
1. “Power adapter and power cord” on page 53
2. “Chassis” on page 55
3. “M.2 solid-state drive thermal kit” on page 56

Removal steps

1. Remove the screw which secure the Wi-Fi card shield to the system board. Find screw specification in the following screw table.

Screw	Quantity	Torque
M2 × L4, flat-head	1	1.5 ± 0.2 lb/in

2. Remove the Wi-Fi card shield and Wi-Fi card from the system board.
3. Slide to remove the Wi-Fi card shield.
4. Disconnect the antenna cables from the Wi-Fi card.



Wi-Fi antenna and Wi-Fi antenna cable

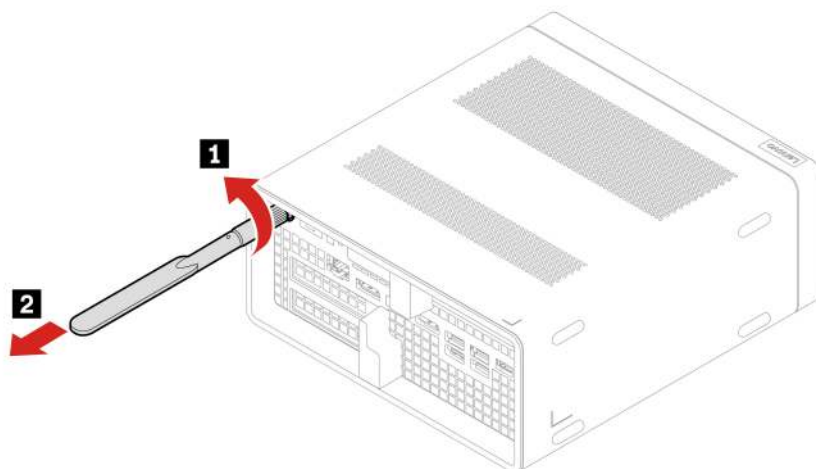
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, remove the following parts in order:

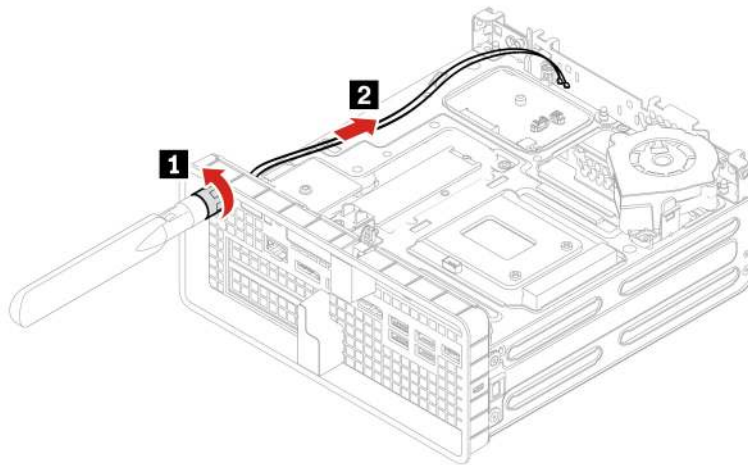
1. “Power adapter and power cord” on page 53
2. “Chassis” on page 55
3. “Wi-Fi card and Wi-Fi card shield” on page 75

Removal steps

1. Contrarotate to remove the Wi-Fi antenna.



2. Remove the screw washer.
3. Pull the Wi-Fi antenna cable inwards to remove it.



Heatsink

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, do the following:

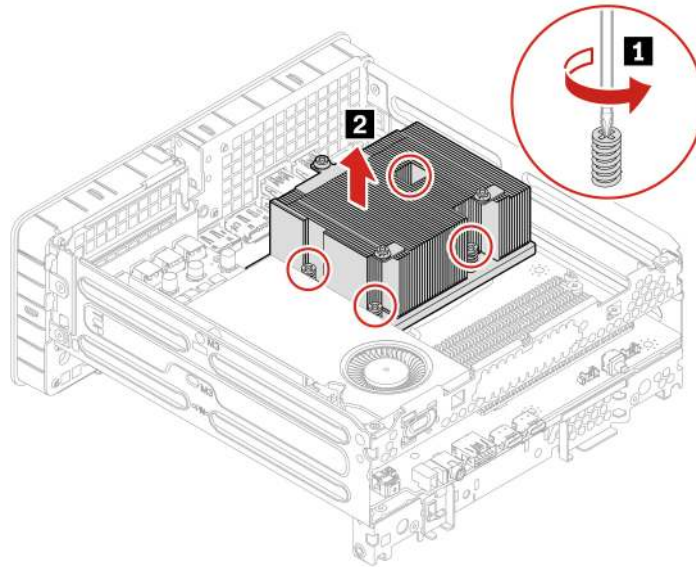
1. Remove the power adapter and cord. See “Power adapter and power cord” on page 53.
2. Remove the chassis. See “Chassis” on page 55.
3. Remove the system fan. See “M.2 solid-state drive” on page 58.
4. Disconnect the power cable from the system board.

Removal steps for 65-watt heatsink

1. Loosen the four screws which secure the 65-watt heatsink to the system board. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L17.8, flat head	4	2.5 ± 0.5 lb/in

2. Lift the heatsink.

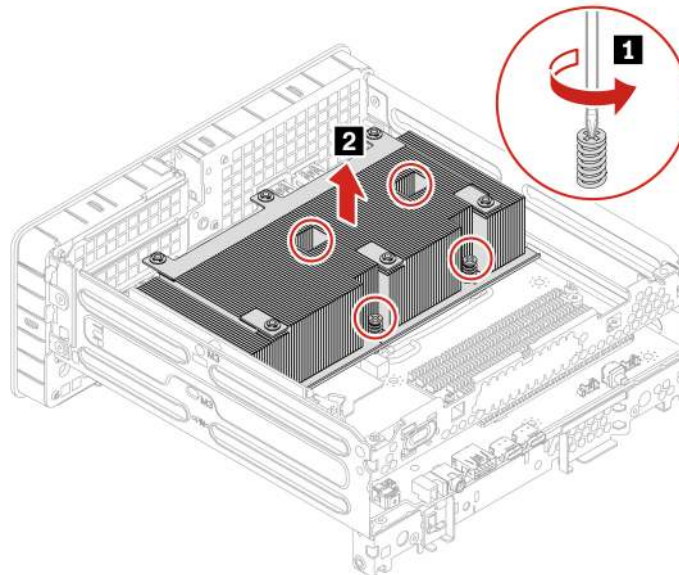


Removal steps for 125-watt heatsink

1. Loosen the four screws which secure the 125-watt heatsink to the system board. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L17.4, flat head	4	3.0 ± 0.5 lb/in

2. Lift the heatsink.



Microprocessor

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

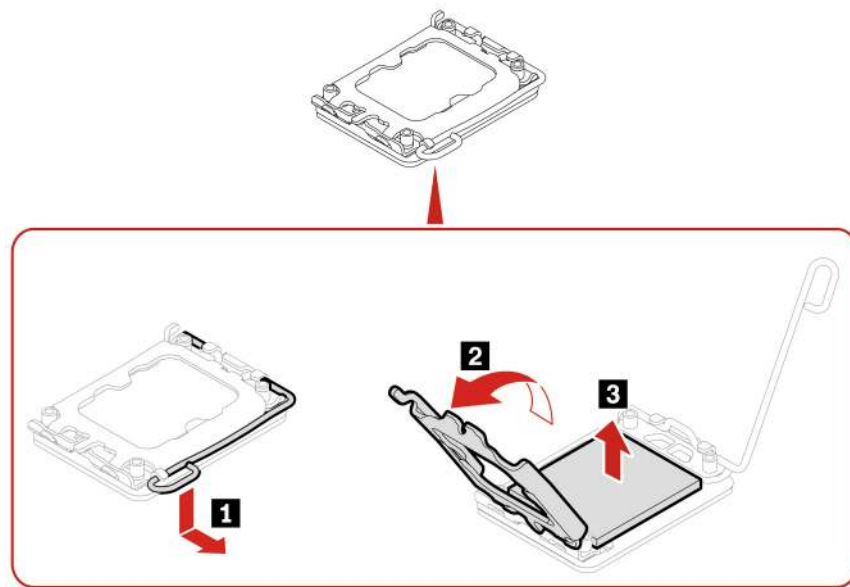
For access, remove the following parts in order:

1. “Power adapter and power cord” on page 53
2. “Chassis” on page 55
3. “M.2 solid-state drive” on page 58
4. “Heatsink” on page 77

Removal steps

Notes:

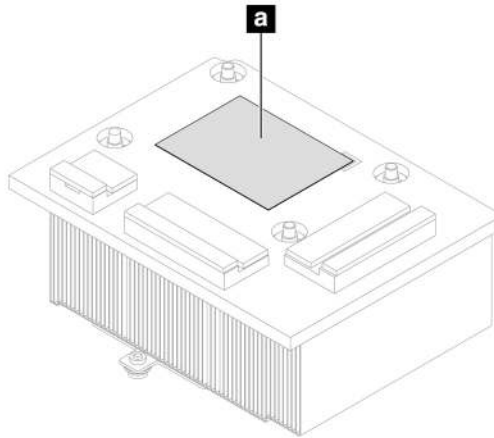
- Your microprocessor and socket might look different from the one illustrated.
 - Do not touch the gold contacts on the bottom. Touch only the edges of the microprocessor.
 - Do not drop anything onto the microprocessor socket while it is exposed. The socket pins must be kept as clean as possible.
1. Press down and push the release level away from the securing tab.
 2. Lift the level upward and open the microprocessor cover.
 3. Gently lift the microprocessor from the socket.



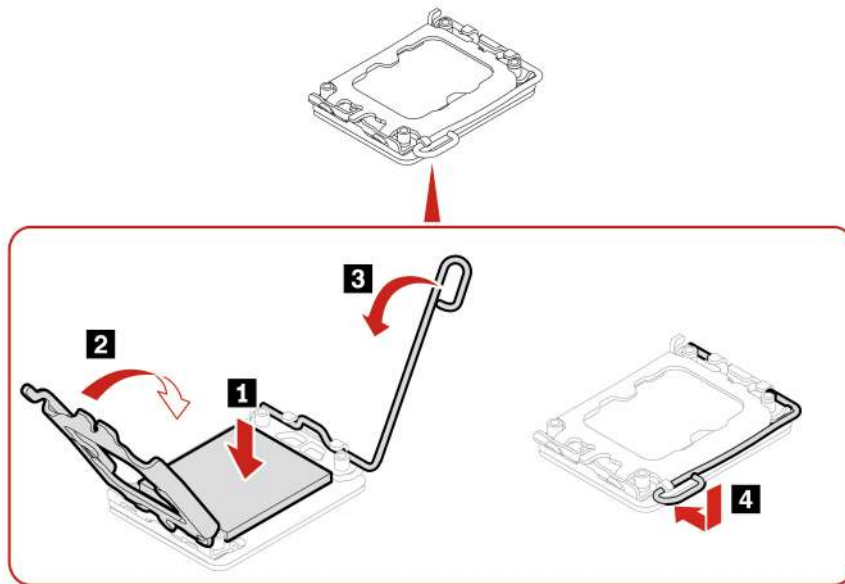
Installation steps

Notes:

- Before you attach the CPU to the computer, clean all thermal grease that has been used and then apply new thermal grease. Apply new thermal grease at an amount of 0.2 grams, on the parts marked **■** as shown in the following illustration. Either too much or too less application of grease can cause a thermal problem due to imperfect contact with a component.



- Do not touch the thermal grease. Do not touch the gold contacts on the bottom. Touch only the edges of the microprocessor.
1. Align the microprocessor with the socket and close the microprocessor cover.
 2. Press down the release level and push it into the securing tab.



System board

Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.



The heat-sink-and-fan assembly and microprocessor might be hot. Before you open the computer cover, turn off the computer and wait for several minutes until the computer is cool.

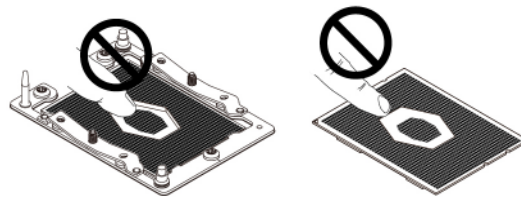
For access, remove the following parts in order:

1. “Power adapter and power cord” on page 53
2. “Wi-Fi antenna and Wi-Fi antenna cable” on page 76

3. “Chassis” on page 55
4. “3.5-inch hard disk drive” on page 64
5. “M.2 solid-state drive thermal kit” on page 56
6. “M.2 solid-state drive” on page 58
7. “LED cable and holder” on page 65
8. “Memory module” on page 66
9. “PCI-Express card converter” on page 70
10. “BMC card” on page 72
11. “Board to board Thunderbolt 4 card ” on page 73
12. “Internal speaker” on page 74
13. “Wi-Fi card and Wi-Fi card shield” on page 75
14. “Wi-Fi antenna and Wi-Fi antenna cable” on page 76
15. “Heatsink” on page 77
16. “Microprocessor” on page 78

Notes:

- Each computer has a unique Vital Product Data (VPD) code that is stored in the nonvolatile memory on the system board. After you replace the system board, the VPD must be updated.
- Your microprocessor sockets and socket covers might look slightly different from the illustrations in this topic.
- Do not touch the pins on the microprocessor socket or the gold contacts on the microprocessor.

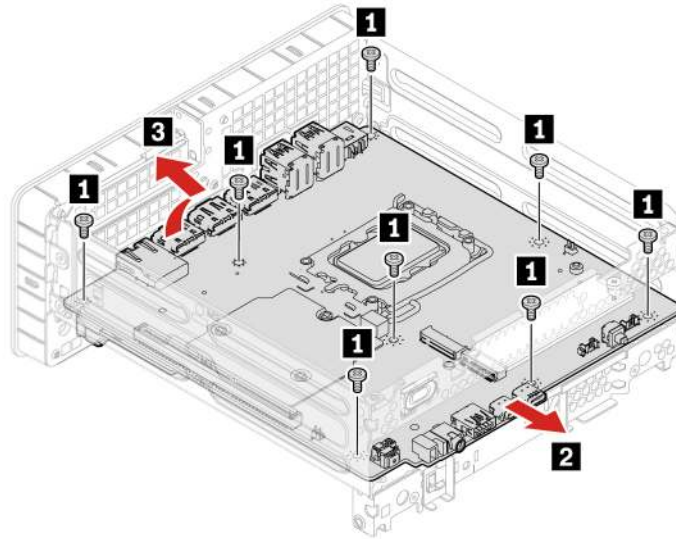


Removal steps

Notes:

- Your microprocessor and socket might look different from the one illustrated.
 - Touch only the edges of the microprocessor. Do not touch the thermal grease on the top. Do not touch the gold contacts on the bottom.
 - Do not drop anything onto the microprocessor socket while it is exposed. The socket pins must be kept as clean as possible.
 - The failing system board must be returned with a microprocessor socket cover to protect the pins during shipping and handling.
1. Remove eight screws which secure the system board to the chassis. Find screw specification in the following screw table.

Screw	Quantity	Torque
M3 x L5, hex screw	8	5 ± 0.5 lb/in



Attention: Use the screws provided by Lenovo to avoid any unpredictable damage to your computer.

2. Carefully lift the system board at an angle.

CMOS battery

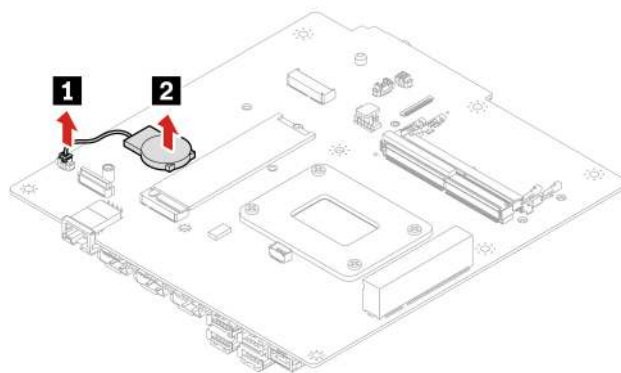
Before you start, ensure that you have read “Prerequisite for CRU replacement” on page 51.

For access, remove the following parts in order, if any:

1. “Power adapter and power cord” on page 53
2. “Wi-Fi antenna and Wi-Fi antenna cable” on page 76
3. “Chassis” on page 55
4. “3.5-inch hard disk drive” on page 64
5. “M.2 solid-state drive thermal kit” on page 56
6. “M.2 solid-state drive” on page 58
7. “LED cable and holder” on page 65
8. “Memory module” on page 66
9. “PCI-Express card converter” on page 70
10. “BMC card” on page 72
11. “Board to board Thunderbolt 4 card ” on page 73
12. “Internal speaker” on page 74
13. “Wi-Fi card and Wi-Fi card shield” on page 75
14. “Wi-Fi antenna and Wi-Fi antenna cable” on page 76
15. “Heatsink” on page 77
16. “Microprocessor” on page 78
17. “System board” on page 80

Removal steps

Disconnect the cable and remove the CMOS battery from the system board.



Appendix A. Notices and trademarks

Notices

Lenovo may not offer the products, services, or features discussed in this document in all countries. Consult your local Lenovo representative for information on the products and services currently available in your area. Any reference to a Lenovo product, program, or service is not intended to state or imply that only that Lenovo product, program, or service may be used. Any functionally equivalent product, program, or service that does not infringe any Lenovo intellectual property right may be used instead. However, it is the user's responsibility to evaluate and verify the operation of any other product, program, or service.

Lenovo may have patents or pending patent programs covering subject matter described in this document. The furnishing of this document does not give you any license to these patents. You can send license inquiries, in writing, to:

*Lenovo (United States), Inc.
8001 Development Drive
Morrisville, NC 27560
U.S.A.
Attention: Lenovo Director of Licensing*

LENOVO PROVIDES THIS PUBLICATION "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE. Some jurisdictions do not allow disclaimer of express or implied warranties in certain transactions, therefore, this statement may not apply to you.

Changes are made periodically to the information herein; these changes will be incorporated in new editions of the publication. To provide better service, Lenovo reserves the right to improve and/or modify the products and software programs described in the manuals included with your computer, and the content of the manual, at any time without additional notice.

The software interface and function and hardware configuration described in the manuals included with your computer might not match exactly the actual configuration of the computer that you purchase. For the configuration of the product, refer to the related contract (if any) or product packing list, or consult the distributor for the product sales. Lenovo may use or distribute any of the information you supply in any way it believes appropriate without incurring any obligation to you.

The products described in this document are not intended for use in implantation or other life support applications where malfunction may result in injury or death to persons. The information contained in this document does not affect or change Lenovo product specifications or warranties. Nothing in this document shall operate as an express or implied license or indemnity under the intellectual property rights of Lenovo or third parties. All information contained in this document was obtained in specific environments and is presented as an illustration. The result obtained in other operating environments may vary.

Lenovo may use or distribute any of the information you supply in any way it believes appropriate without incurring any obligation to you.

Any references in this publication to non-Lenovo Web sites are provided for convenience only and do not in any manner serve as an endorsement of those Web sites. The materials at those Web sites are not part of the materials for this Lenovo product, and use of those Web sites is at your own risk.

Any performance data contained herein was determined in a controlled environment. Therefore, the result obtained in other operating environments may vary significantly. Some measurements may have been made on development-level systems and there is no guarantee that these measurements will be the same on generally available systems. Furthermore, some measurements may have been estimated through extrapolation. Actual results may vary. Users of this document should verify the applicable data for their specific environment.

This document is copyrighted by Lenovo and is not covered by any open source license, including any Linux agreement(s) which may accompany software included with this product. Lenovo may update this document at any time without notice.

For the latest information or any questions or comments, contact or visit the Lenovo Web site:

<https://pcsupport.lenovo.com>

Trademarks

LENOVO, LENOVO logo, THINKSTATION, and THINKSTATION logo are trademarks of Lenovo. Intel, Optane, Core, and Thunderbolt are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. Microsoft, Windows, and Cortana are trademarks of the Microsoft group of companies. DisplayPort is a trademark of the Video Electronics Standards Association. The terms HDMI and HDMI High-Definition Multimedia Interface are trademarks or registered trademarks of HDMI Licensing LLC in the United States and other countries. Kensington and MicroSaver are registered trademarks of ACCO Brands. Wi-Fi, Wi-Fi Alliance, and Miracast are registered trademarks of Wi-Fi Alliance. USB-C is a registered trademark of USB Implementers Forum. All other trademarks are the property of their respective owners.

Lenovo